

Delft University of Technology
Master's Thesis in Embedded Systems

Computational Imaging for Earth Surveillance

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Master's Thesis in Embedded Systems

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Abstract

Cameras are used in various applications and one such common application has been space. Delfi Space is the CubeSat Development program of the Delft University of Technology and a subprogram of Defi-Space is Delfi-PQ which aims to develop PocketQubes which are an order of magnitude smaller than the CubeSat standards. One of the advanced payloads that would potentially be a part of the Delfi-PQ is an imager/camera. The imager needs to be as small as possible in order to fit into the Delfi-PQ satellites. The design of the camera has remained the same throughout the years and one of the reasons that increase the thickness of the camera is the presence of lenses. A way to reduce the size of the camera would be to remove the lens out of the equation. However, this introduces additional problems and trade-offs in the camera. These lenses can be replaced by masks/coded apertures. One of the additional steps in using coded-apertures is that additional computational steps need to be performed in order to reconstruct the image. The kind of computation that needs to be performed depends on the kind of masks that would be used. In this thesis, a separable mask is chosen and computer simulations on separable masks have been performed. Two image sensors that can be used in the picosatellite were chosen for implementation and the hardware/software is designed and developed. The experimental setup for determining the field of view of a lensless camera has been developed and tested. One of the trade-offs observed through the experiments is that the acceptance angle of a lensless imager had reduced by 38 percent and 31.8 percent in the horizontal and vertical directions compared to a conventional lens-based system. Based on the experimental results, the field of view of the camera has also been determined. A singular value decomposition based method has been developed and is used to align and calibrate the camera with the mask. The final step is estimating the system matrices of the lensless system. The system matrices enable the perfect reconstruction and a complete realization of a separable mask based lensless camera. A scheme for estimating the system matrices of the lensless imager using Hadamard basis is proposed and confirmed using simulations and the strategy for experimental verification is proposed. As far as we know, this is the first study that focuses on designing and developing a lensless camera in the visible light domain for use in picosatellites.

Preface

This document contains the work that I have been doing for the past eight months. These months just flew by and I enjoyed working on this multi-disciplinary project. Firstly, I am thankful to the almighty for providing me the strength to overcome various challenges I faced over the past two years of my master program which has been highly demanding. I have a long list of people whom I would like to thank and without whose support this project could not have been completed. I would like to first thank my parents for providing me the financial support for coming to the Netherlands and doing my master studies at TU Delft. Without their encouragement and support, I would not be where I am now. Next, I would like to thank my master program coordinator and my supervisor, Arjan van Genderen who accepted to supervise me in this multi-disciplinary project. His invaluable guidance has been extremely helpful in this project and throughout my master program. I would like to thank Delfi Space Program Manager, Jasper Bouwmeester, who first introduced me to my second supervisor Hans Kuiper. Hans provided me the support and was instrumental in understanding the requirements for designing the imager. Next, I would like to thank Paul Urbach who introduced me to the Optica Research Group which is where I did all the experiments. I am extremely thankful to Ph.D. students, Yifeng Shao and Sander Konijnenberg. Yifeng was also my daily supervisor and helped me with understanding the theoretical physics, simulation of imaging algorithms and also on how to work with optical instruments. He continuously encouraged me to overcome challenges I faced along the way. I could not have asked for a better supervisor. I would also like to thank Sander for many discussions that very highly insightful and helped me to cross hurdles that I faced. On the whole, the Optica Research Group was a very nice place to work with very sociable people. I would like to thank the chair of the thesis committee, Stephan Wong for agreeing to be a part of the thesis committee. Lastly, I would like to thank my friends in Delft for their support and encouraging words in stressful times.

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Chapter 1

Introduction and Problem Statement

The history of cameras goes back to 13th century when Aristotle first noticed how light passing through a small hole in a darkened room produced an image of the sun on the wall. Throughout the centuries, the basic design of cameras has been continuously changing with different versions of the ‘Camera Obscura’. ‘Camera Obscura’ is a phenomenon that occurs when a scene is projected onto a pinhole and the image of that scene is formed on the surface opposite to that of a pinhole.

In a pinhole camera, light passes through the pinhole and forms an image on the sensor/image plane. As the size of the pinhole increased, the quality of the image formed on the plane decreased and as the pinhole size became smaller, the lesser light was allowed which resulted in a decreased field of view. With the development of science and due to the limitations of the pinhole, lenses were introduced to increase the size of the aperture, the sharpness of the image and the light throughput. As humanity progressed with the rapid pace of technology, we were able to capture images and store them in a film. With the digital explosion in the early 1990s, the thin films were replaced by Charged Couple Devices(CCD). Then came the cameras based on Complementary Metal Oxide Semiconductors(CMOS). CCD and CMOS sensors reduced the size of cameras considerably and it was possible to develop low-cost cameras in a large number. However, cameras have retained the lens throughout the years. Cameras are used for various applications and one such application is the space exploration domain.

1.1 Context

The Delfi program focuses on the development of University class(U-Class) spacecraft(CubeSats) at the Delft University of Technology, to provide hands-on education for students and also provide technology demonstrations for

the Dutch Space Industry. The satellites that have been launched under the Delfi program are as follows:

- Delfi-C3: Delfi-C3 is the first university class satellite and also the first nano-satellite from the Netherlands. It was launched on April 28, 2008, from India. Delfi-C3 is a full mission success and is still operational[2].
- Delfi-n3Xt: The Delfi-n3Xt(pronounced as Delfi-Next) is the second set of CubeSats developed as the successor to Delfi-C3. It was launched from Russia on November 21, 2013. It was able to log data for three months and perform all foreseen technology demonstration experiments.

Delfi-PQ programme is a sub-programme of the Delfi Space programme that aims at developing extremely small but highly capable PocketQube satellites. PocketQubes are an order of magnitude smaller than the well known CubeSat standard which formed the basis of previous Delfi satellite projects. The dimensions of a PocketQube satellite would be $50\text{ mm} \times 50\text{ mm} \times 178\text{ mm}$ and their volume would be approximately eight times smaller than CubeSats. One of the advanced payloads that would potentially be part of the Delfi-PQ would be an imager/camera that would be extremely small and fit into the dimensions specified by the Delfi-PQ team. The thickness of the camera must be less than or equal to 10 mm.

1.2 Problem Statement

In order to reduce the size of a camera, it would be necessary to remove the lens from the camera which is primarily responsible for the thickness of the camera. The primary focus of a lens would be to focus light from distant objects onto the image sensor. Light from distant objects reaches the sensor even without the lens except that the light is incoherent and the image sensor would not be able to form the object properly without a lens. However, the lens could also be replaced by coded apertures. Coded Apertures have been used in the late 20th century to image X-Ray sources of light. Lensless coded aperture cameras can be as small as $500\text{ }\mu\text{m}$ thick[13]. By using lensless cameras, we could potentially reduce the form-factor multiple times to suit the requirements of Delfi-PQ. Apart from this, it would be the first attempt to use a lensless camera for use in satellites to image astronomical objects in the visible light spectrum. In the case of lensed imaging, the image of the scene is directly obtained on the sensor. That does not happen in the case of lensless imaging. In lensless imaging, one would need to computationally reconstruct the object scene using various computational methods. This is one of the trade-offs that we need to sacrifice in the case of lensless imaging. This thesis would address the following research question: **Is it possible**

to design “lensless coded aperture” cameras with a small form-factor(thickness <= 10 mm) using COTS(commercially available off-the-shelf) components that can be used in U-class Spacecraft ?

This question can be broken down into the following sub-questions:

- What would be the image sensor that can be used for the camera?
- How do we design the hardware and software for such a camera that can be used in Delfi-PQ satellite?
- What would be the field of view and spatial resolution of the lensless camera?
- What would be the computational algorithm that would be used in such a lensless camera?
- How do we experimentally prove the concept of lensless imaging?

Based on the above set of questions, the following goals have been determined for the project:

- Perform a survey of image sensors and choose an image sensor that could be used for lensless imaging in the Delfi-PQ.
- Design the hardware and software prototype using a commercially available microcontroller platform.
- Design an experimental setup for determining the field of view and spatial resolution of the lensless camera.
- Design an experimental setup to prove the concept of lensless imaging using existing computational methods.

1.3 Assumptions

The thesis makes the following assumptions:

- The imaging system needs to use a COTS microcontroller platform that could be easily integrated with onboard computer module on the Delfi-PQ. This assumption is fair as the previous Delfi satellites use commercially available microcontroller platforms for their subsystems.
- The second assumption is that it would be possible to stream down the data from the satellite to the earth and perform computations in the ground station and perform computational reconstructions. Lensless imaging requires computational reconstruction and it would be a computationally complex task to perform complex Fourier computations

onboard satellite. Apart from this, various computational techniques can be added to perform better reconstructions at a later stage. This assumption is valid since the previous Delfi satellites periodically send back data to the earth. This assumption allows a greater flexibility while designing the system.

- It is also assumed that there is no loss of image data in the transmission between the satellite and ground station and that the image is sent as stored by the imaging module. The assumed system architecture is shown in Figure 1.1.

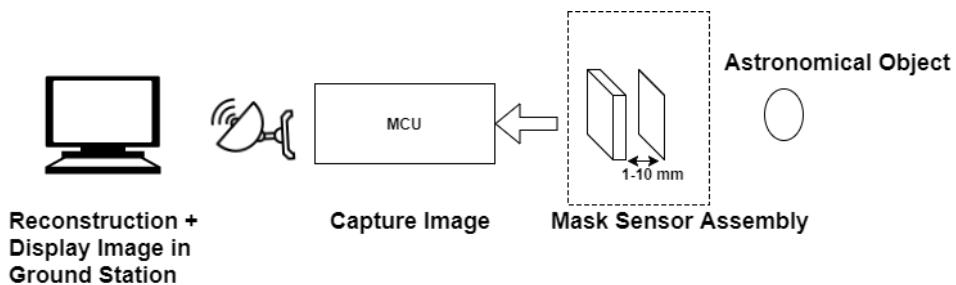


Figure 1.1: Assumed System Architecture

1.4 Thesis Outline

Chapter 2 of the thesis discusses the background information needed to understand the rest of the thesis. It also discusses the factors that were used to select different components of the camera such as the image sensor, compression algorithms and the mask that needs to be used to achieve lensless imaging. Chapter 3 of the report discusses the modeling and simulation of the computational algorithm that needs to be used to reconstruct images that are produced by the lensless camera. Chapter 4 of the report describes the implementation of the hardware and embedded software of the camera. It discusses the exposure control of the sensors chosen in Chapter 2 of the report. The power consumption profile of the camera is also presented. Chapter 5 of the report discusses the experimental setup that was used to calculate the acceptance angle of the image sensor. The calculation results for the field of view and the spatial resolution are also presented. Chapter 6 of the report describes the experimental setup that was used to calibrate and align the image sensor with the mask. The mask was achieved using spatial light modulators(SLM). The chapter also describes the effect of the spatial light modulators on the mask properties. Chapter 7 of the report describes the procedure and the scheme that can be used to estimate the system matrices of the lensless imaging system. The proposed scheme was

verified using simulations which are also described. The final chapter of the report answers the research questions described in this chapter and also proposes the future work that can be done to completely realize the concept of lensless imaging.

Chapter 2

Background and selection criteria

In this chapter, a state-of-the-art study will be presented that would assist in the design of the lensless imager that can be used onboard the Delfi-PQ Satellite. This chapter also provides background information that will be useful in understanding the concepts covered in the later chapters.

2.1 Camera Computational Pipeline

In order to design a lensless imaging system, we must first look at the computational imaging pipeline of existing cameras. Since the lensless camera basically uses computation to reconstruct images, it is important to understand the computational pipeline of existing camera systems and make necessary modification in the design of the existing pipeline to suit the system. The computational imaging pipeline of existing camera systems is shown figure 2.1[26]. As shown in figure 2.1, there are five main components

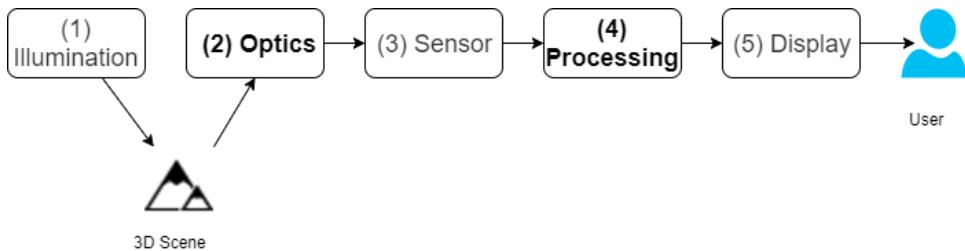


Figure 2.1: Computational Pipeline of Existing cameras

that can be controlled computationally in existing systems. Illumination of the scene can be controlled to produce an enhanced picture. Optics could be controlled to limit the amount of light entering the sensor and thereby

controlling the image produced by the sensor. The sensor can also computationally modify the date it receives to de-noise, adjust the blackness/white in an image. Post-processing can also be done on the image produced by the sensor to improve the image produced by the sensor. Finally, a display can also be modified computationally to produce certain effects on the user. And of course, the user can control any of these components to produce the effect he desires. But in the case of the lensless imaging system, we would be modifying the optics and the processing components of the pipeline to reduce the size of the camera. The components to be modified are darkened in figure 2.1.

2.2 Satellite Imaging Architectures

Since the camera is going to be capturing pictures of the earth, it would be required to study the existing imaging architectures currently being used in satellites and how the design of the lensless camera would fit into the existing imaging architectures. We will first look into the terminology commonly used in space instrumentation. As the imager is carried along the orbit of the earth, it images a strip on the surface of the earth. The width of the strip is called the ‘swath’. The direction along which the satellite moves or images is called the ‘along-track’ direction and the direction perpendicular to it is called the cross-track direction[6]. Figure 2.2 describes this terminology and some other terms as well. Three major types of scanning architectures are

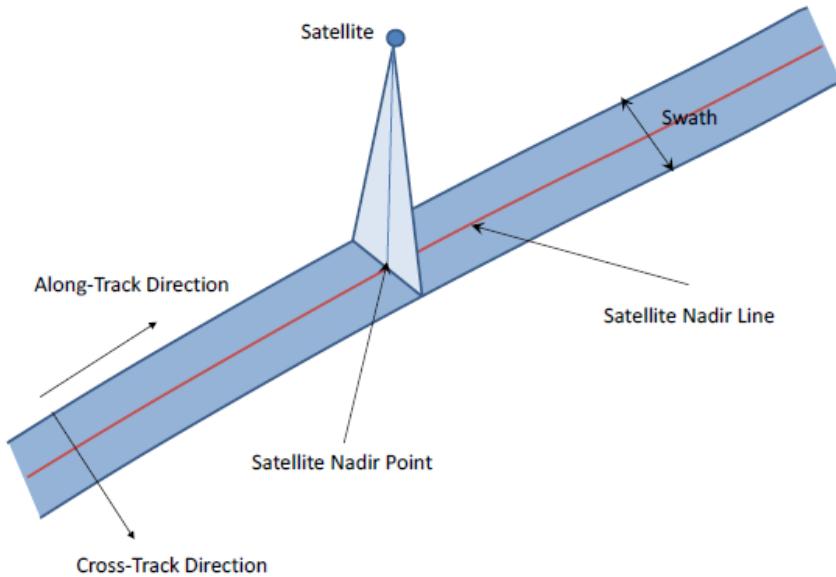


Figure 2.2: Various Imaging Terms[6]

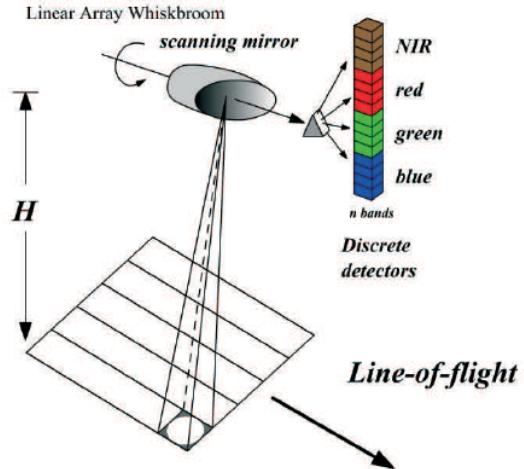
employed in space instruments, namely:

- Whiskbroom Line Scanner: In this type of scanning architecture, a detector element detects its instantaneous field of view which is projected onto a pixel element. In this scanning type, the surface of the earth is scanned in lines. A scanning mirror would project a very small area of the earth onto the single pixel element. The scanning mirror would then rotate to project the next element of the line onto the next pixel. Depending on the motion of the satellite, the next line of the detector is scanned and projected on to the next line on the surface of the earth. An advantage of this type of detector is that it would be possible to obtain a very large field of view. However, it also comes with a disadvantage that a very high sampling frequency is required to get decent resolutions. Typically, an earth observation satellite would move at 6.5 km per second. In order to get a resolution of 100 meters per pixel, it would be required to sample at least 65 lines per second. For a swath of 1000 pixels, it would be required to sample at 65000 elements per second. Apart from this, there is very limited time for each detector element which would result in low spatial resolution[32]. Another main disadvantage is that mechanical components would be required to project different parts of the surface of the earth on to the detector element. This type of scanner is also called as the along-track scanner. Mathematically, the measurement of the detector element (X, Y) can be described using

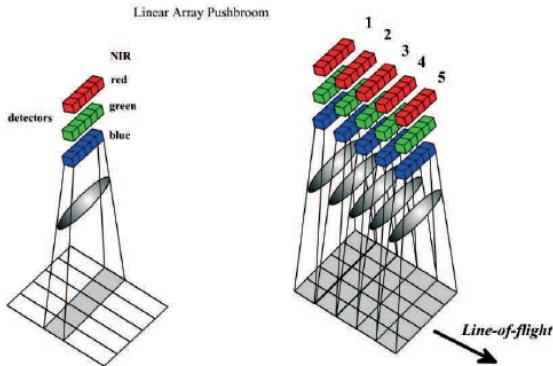
$$(X, Y) = f(t_x, t_y)$$

where t_x and t_y is the time at which the image is captured in the corresponding location

- Pushbroom Line Scanner: In this type of architecture, the orbital motion of the sensor is used to image the swath instead of using a mirror as in the case of whiskbroom scanner. The field of view in the cross-track direction is imaged by the corresponding line detector array. Successive lines are imaged and sampled by the multiplexer as the sensor moves across the surface. The time between sampling two successive lines can be the time it takes for the satellite to move that distance. The most commonly used detector for a push broom scanner is Charge Coupled Devices(CCD). One of the main advantages of this type of scanner is that it requires no moving parts. Due to this, it is possible to obtain very high scanning rates($\leq 1\mu$ second). This also leads to lower noise in the received signal[32]. The disadvantage is that a large number of detectors are required to image a large piece of an area of the earth. In addition to this, it requires an optical arrangement that could obtain a wide field of view. Mathematically,



(a) WhiskBroom Scanning



(b) Pushbroom Scanning

Figure 2.3: Push Broom and Whisk Broom Scanning[32]

the measurement of the detector element (X, Y) can be described using

$$(X, Y) = f(x), f(t_y)$$

where $f(x)$ represents the sensor output and $f(t_y)$ represents the time at which the subsequent rows are imaged.

- **Staring Array:** Staring arrays use 2-D CCD/CMOS detectors to capture an entire area on the surface of the earth. These are also called as framing cameras. This provides speed-up and step-and-stare mechanism is employed wherein observations are made intermittently after a certain number of steps in the cross-track direction. The advantage is that moderate field of view optics is only required in this case[32].

Mathematically, the measurement of the detector element (X, Y) can be described using

$$(X, Y) = f(x), f(y)$$

where $f(x)$ and $f(y)$ represents the sensor output.

2.3 Spatial Resolution and Field of View

Two important factors that come into account when developing cameras for space applications are the spatial resolution and field of view. These factors determine the performance of the camera and it is important to know how these cameras will perform when designed.

2.3.1 Spatial Resolution

Spatial resolution in remote sensing refers to the smallest area represented by the pixel element of the detector. The impact of different spatial resolutions on imaging a house object is shown in Figure 2.4. For example, if a house on earth measures $30 m \times 30 m$, a camera with a spatial resolution of $30 m$ cannot image the house completely and the pixel is going to be the average color of that particular area which is $30m$. If the spatial resolution is reduced to $5 m$, then we can differentiate between different components of the house. An even smaller spatial resolution of $1 m$ will enable us to see the finer details of the house components.

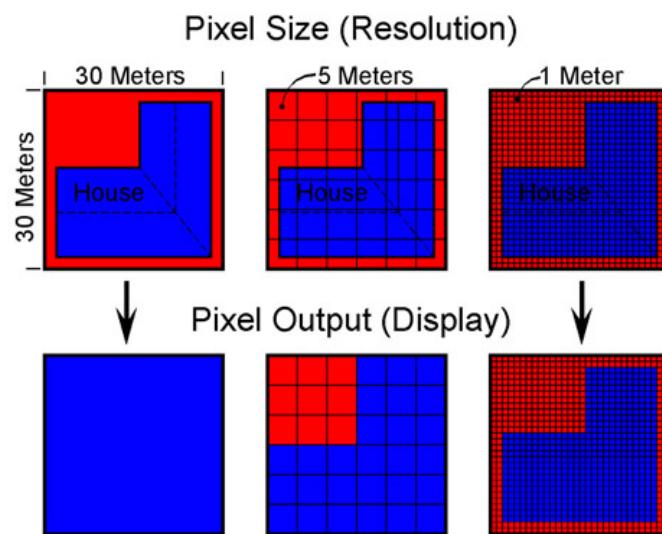


Figure 2.4: Picture Quality variation according to different spatial resolutions[21]

In remote sensing, a system with high spatial resolution is one which has a resolution of $0.41 - 4$ m per pixel, a system with low spatial resolution has a resolution ranging from $30 - 1000$ m per pixel[21]. The spatial resolution of a system can be determined by the equation 2.1.

$$d_s = \frac{d_p}{d_t} * d_h \quad (2.1)$$

where d_s indicates the spatial resolution, d_p indicates the individual pixel size of detector element, d_h indicates the height of the instrument from earth and d_t indicates the thickness of the camera or the distance of the lens/mask from the sensor.

The equation 2.1 is obtained by using the simple triangular rules and the relation can be obtained by using Figure 2.5.

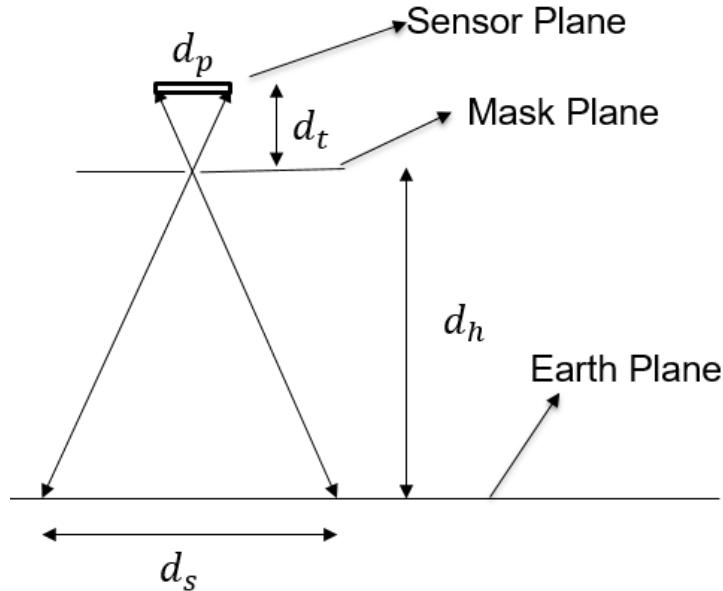


Figure 2.5: Spatial Resolution Calculation

2.3.2 Field of View

The field of view is the amount of area of the surface of the earth that can be imaged by the sensor. In a lens-based system, the field of view is determined by the chief ray angle of the lens in use. In a lensless system, the field of view is determined by the acceptance angle of the CMOS/CCD sensor in use. The field of view can be determined by the equation 2.2.

$$d_{fov} = 2 * d_h * \tan(\theta_{cra}) \quad (2.2)$$

where d_{fov} is the area that can be imaged by the sensor, d_h determined the height of the instrument from the surface of the earth and θ_{cra} is the acceptance cone or the acceptance angle of the sensor elements. This equation can be determined by using simple triangular laws and this is shown in Figure 2.6. Sensors used by the Landsat program(program by NASA for

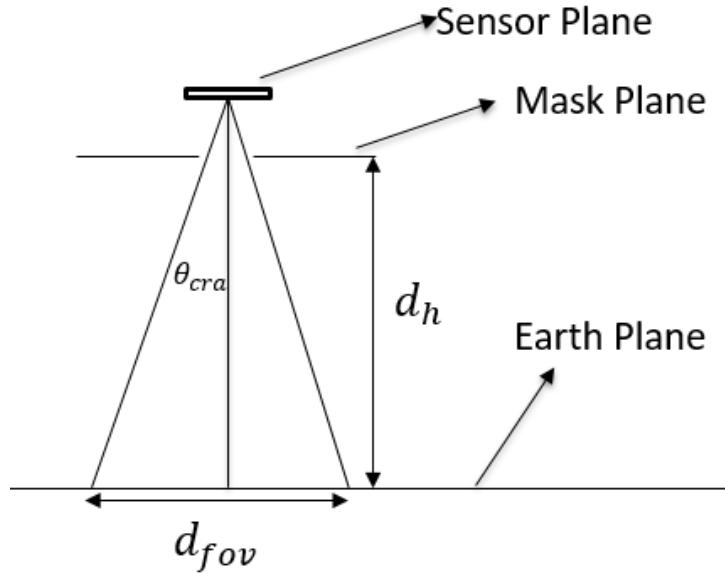


Figure 2.6: Field of View Calculation

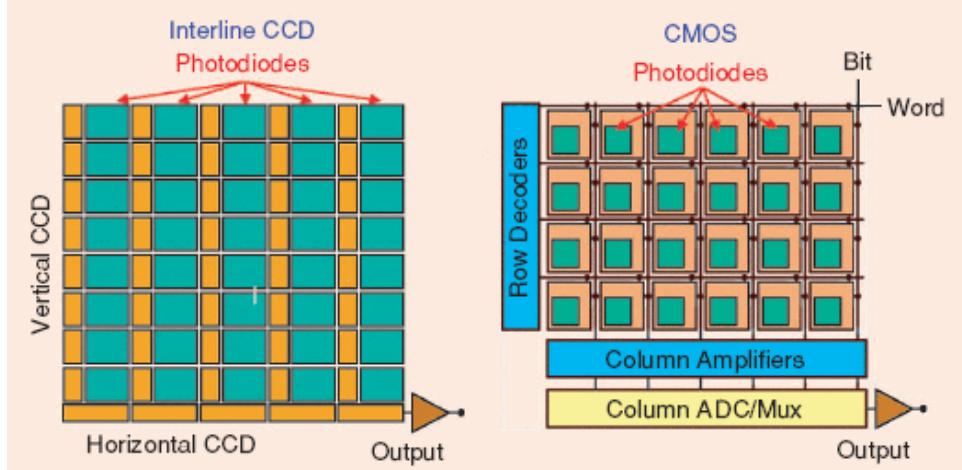
earth observation satellites) have a field of view of $185 \text{ km} \times 185 \text{ km}$ at a height of 705 kilometers from the surface of the earth[9].

2.4 Trade-off Analysis

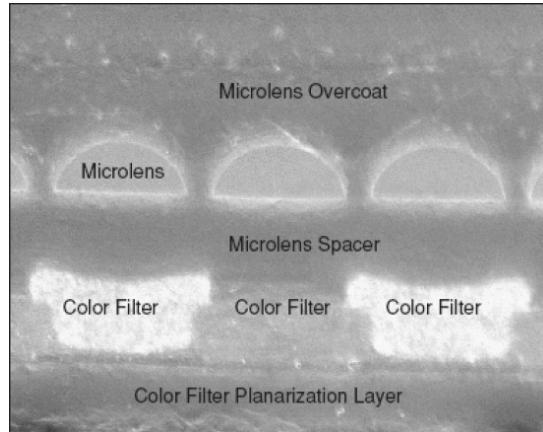
2.4.1 Camera Sensor

The camera sensor is the core of the Delfi-PQ Imager. The performance of a camera is mainly limited by the image sensor that it uses. The camera sensor can be of two types namely, CCD(charge coupled device) or CMOS(Complementary Metal Oxide Semiconductor). Both the types of sensors have their own advantages and disadvantages. To understand the challenges that each type of sensor poses, we must understand how the sensors are designed. The image sensor typically contains a two-dimensional array of sensors that convert the incoming light into electrical signals. To obtain imaging in the visible light domain, a color filter is added over the top of the array of pixels, that filter and allow only the red, green and blue components. The analog voltage is then converted to digital data using and

then the process of demosaicking is used to convert the image intensity map to the actual object image [28]. The image sensor has a micro-lens array in order to increase the amount of light incident on the surface of the sensor. In a lensless system, the field of view of the camera is also determined by the acceptance angle of the micro-lens array(See Figure 2.7b).



(a) Readout architectures of CMOS and CCD



(b) Micro lens array and other components in a image sensor

Figure 2.7: Image Sensor Architectures[28]

The difference in CMOS and CCD sensors mainly lie in the readout architectures. In CCDs, the electrical charge is shifted out through the horizontal and vertical detector elements and are converted to a voltage through an amplifier. In CMOS sensor image architecture, the charge is read out one row at a time similar to RAM using row-column select switches[28]. The architecture of the CCD makes it possible to design sensors with very small pixel-sizes and also leads to lesser readout noise. The CMOS architecture

enables extremely fast readout but introduces additional fixed pattern noise and temporal noise due to the introduction of circuitry in each pixel. Manufacturers produce both CMOS and CCD types of sensors and we can choose an architecture depending on the type of application.

These CMOS/CCD sensors can be categorized under the staring array type of imaging architectures that we mentioned previously. The following factors have been chosen to make a trade-off between the different image sensors available on the market:

1. Resolution: When rating a camera, the first thing that comes to the mind is the resolution of the camera. The resolution of a camera is directly dependent on the number of pixels in the image sensor of the camera.
2. Power Consumption: In the design of the imager, the most important factor is the power consumption of the entire imager. The majority of the power consumption by the imager is dependent on the power consumption of the image sensor.
3. Availability: Even though there is an innumerable number of image sensors in the world, availability of image sensors is quite low when it comes to small-scale production. Many image sensor manufacturers require large-scale orders.
4. Quantum Efficiency(QE): Quantum Efficiency is the measure of the efficiency of the camera sensor to convert incoming photons into electrons. The ratio of electrons generated during the digitization process to photons is called quantum efficiency. This factor is extremely important, however, most manufacturers do not provide this information. This factor is ignored since a majority of the cameras studied do not specify this information.
5. Pixel Size: Pixel size is the size of each pixel unit in the CMOS camera. It is also an important factor considering that the signal produced by the CMOS sensor depends on the pixel size as well. It also determines the spatial resolution of the camera. The larger the pixel size, the better is the signal provided by the image sensor. The relationship between the signal produced by the sensor and the pixel size is shown by equation 2.3.

$$\text{Signal} = \text{Light Density} * (\text{Pixel Size})^2 * QE \quad (2.3)$$

6. Electronic Interface: The electronic interface that can be used to retrieve data from the image sensor also plays an important role. Since the project uses a low-power microcontroller that has limited communication capabilities, it would be wise to choose an interface that is

supported by the microcontroller. Recently available image sensors use LVDS/MIPI interface to send data. These interfaces are not supported by most of the 8-bit/16-bit microcontrollers that would be used to acquire the image from the sensors. An ideal image sensor would use I2C/SPI/RS232 based electronic interfaces to transfer image data from the sensor to the microcontroller.

7. Dynamic Range: Dynamic Range and Signal-to-Noise Ratio(SNR) are used interchangeably in CMOS sensors. The only difference is that dynamic range considers only the temporal dark noise while SNR includes the root mean square of the shot noise as well. The dynamic range is given by the equation 2.4.

$$\text{Dynamic Range} = 20\log\left(\frac{\text{Signal}}{\text{Temporal Dark Noise}}\right) \quad (2.4)$$

8. Voltage Level: Voltage level also has to be taken into account while choosing the sensor because if the image sensor needs a voltage level higher than that of the main satellite bus voltage, then additional circuitry has to be introduced to step up the voltage level which in turn increases the overall system power. The ideal operating voltage of the camera must be in the range of 3-5 V.
9. Operating Temperature: Operating temperature is an important factor to take into account when choosing an imaging sensor. Since the camera is going to operate in space, it is better if the image sensor has a higher operating range of temperature.
10. Overall Size and Weight: As the imager has to fit within specific dimensions, the overall size and weight of the image sensor also needs to be taken into account.
11. Frame Rate: Even though it is not required to have a camera sensor that is capable of high frame rates, it is an added advantage and higher frame rate camera could help in imaging larger areas of the earth if required.
12. Price: While there are no specific cost constraints in the project, the price has also been taken into account.

In [33], a survey of camera modules for a CubeSat space Mission has already been carried. The following candidates have been chosen for analysis. These candidates are chosen based on [33] and also on the latest image sensors available on the market.

- (a) IDS UI- 1646LE USB 1.3MP: This is a 1.3-megapixel camera previously used for the M-Cubed CubeSat mission by the University of

Michigan[36]. Although a very attractive candidate, the USB 2.0 interface and 2W power consumption are the drawbacks. More recently available cameras can offer a better power consumption.

- (b) C3188A: It is a low-resolution camera which uses OV7620 as the CMOS sensor. It offers a simple I2C electronic interface. Low resolution and unavailability are the drawbacks of this camera. It has been used in ITU-pSAT-1 [33], the first student-designed pico-satellite of Turkey.
- (c) PC67XC-2 CCD: This CMOS sensor has been used Norwegian satellites nCube-1 and nCube-2[33]. The extremely low resolution of this camera is a huge drawback.
- (d) MicroCam TTL: This camera also has a very simple RS232 based electronic interface with a maximum available resolution of 640×480 . The low resolution and unavailability of this camera are major drawbacks.
- (e) PB-MV40: This is one of the world's fastest cameras which can give us a frame rate of 240 frames per second. The main disadvantage is that it requires an FPGA/ASIC interface which will drastically increase our development time.
- (f) Omnivision OV2640: This CMOS sensor, although not used in previous lensless imaging studies or CubeSat missions is very interesting because it offers a very low power consumption. Open source drivers and electronic interface in the forms of SPI and I2C is available for this sensor. This and another candidate OV5642 are manufactured by a vendor called Arducam and come with very easily available electronic interfaces such as I2C and SPI.
- (g) Sony ICX285AL: This candidate was chosen because it was also used in previous lensless imaging studies[13]. There are USB versions of this camera that can be used along with a PC. The major disadvantage is that custom electronic interface needs to be developed for use in pico-satellites.
- (h) Omnivision OV5642: This was another CMOS sensor chosen because of the easy availability of open-source drivers and electronic interfaces needed for a CMOS sensor. This would help us drastically reduce development time of the camera and focus on lensless imaging algorithms. Another advantage is that it can produce 1080p resolution pictures. The same open source libraries as used for OV2640 can be used.
- (i) MCM20027: This camera was used in AAUSAT, which is the satellite program of the University of Aalborg. Unavailability of the sensor with a dedicated electronic interface is a major drawback.

Table 2.1: Comparison of Different Image Sensor Candidates

Candidates Factors \	(a)	(b)	(c)	(d)	(e)	(f)	(g)	(h)	(i)
Optical Parameters									
Resolution	+	-	-	-	++	+	++	++	+
Pixel Size	+	++	X	++	++	+	++	+	++
Frame Rate	+	+	+	+	+++	+	+	+	+
Electrical and other parameters									
Power Consumption	--	--	---	++	-	++	-	--	--
Availability	-	+	---	---	---	++	++	++	---
Electronic Interface	+	+	---	++	---	++	---	++	+
DR and SNR	X	+	X	++	+	++	+	++	+
Voltage	+	+	---	++	+	++	+	++	+
Operating Temperature	+	+	+	+	+	+	+	+	+
Overall Size and Weight	+	+	+	+	+	+	+	+	+
Price	-	+	X	X	---	++	X	+	X
Points	3	7	-10	9	1	17	7	13	4

The sensors are rated from +++ indicating that the sensor provides the best performance for the particular factor and --- indicates the worst performance for the particular factor. Based on Table 2.1, OV2640 would be the best choice for development of the lensless camera. It is a medium resolution, low-power choice. OV5642 was also bought in case of any design issues with OV2640. OV5642 is a high-power, high-resolution choice.

2.4.2 Compression Algorithms

Data Compression plays a very important role when it comes to space missions. It is a very important aspect of the system design of a lensless camera for space application as the image that needs to be sent down to earth needs to be compressed as much as possible. Various surveys[34][29][23] have been conducted previously in-terms of which compression algorithm would best preserve the data and provide maximum compression at the same time. Compression algorithms can be divided into two types namely lossy and lossless. Lossless compression algorithms are algorithms in which we can reconstruct the original image without any loss of data. Typical examples of lossless algorithms include Portable Network Graphics Format(PNG), Bitmap Format(BMP), TIFF(Tagged Image File Format). Lossy compression algorithms are compression algorithms in which we cannot completely reconstruct the original image. However, lossy compression factors offer a very high compression ratio compared to loss-less algorithms. Lossy Compression

algorithms include DCT(Discrete Cosine Transform), JPEG(Joint Photographic Experts Group), SPIHT(Set Partitioning in Hierarchical Trees)[29]. A survey conducted for European Student Moon Orbiter Mission[29] has reviewed various possible compression algorithms that could be used for lunar imaging. The compression algorithms were evaluated on the basis of Mean Square Error(MSE), Peak Signal to Noise Ratio(PSNR), Normalized Cross-Correlation(NK), Averaged Difference(AD), Structural Content(SC), Maximal Difference and Normalized Absolute Error(NAED). The reviewed compression formats were BMP, CGM, GIF, JPEG, PNG, TIFF, WebP. Loss-less compression generally does not offer a compression ratio of more than 2 due to the entropy present in real-life artifacts. Since space missions offer a limited communication link-speed, the compression ratio needs to be extremely high which cannot be offered by lossless compression. This cannot be offered by lossless compression and hence we need to go for lossy compression formats. It can be seen from table 2.2 that JPEG and SPIHT perform better compared to DCT. It can be seen that JPEG offers better performance in terms of Mean Squared Error. However, SPIHT offers a higher compression ratio.

Table 2.2: Ranking of Different Compression Algorithms

Method \ Factors	MSE	PSNR	AD	Compression Ratio	Implementation Needed
Method					
JPEG	1	1	1	2	No
DCT(With Zip)	2	2	1	3	No
SPIHT	3	1	1	1	Yes

JPEG algorithm is chosen for implementation since it offers equivalent performance to SPIHT and JPEG compression engine is present in most of the commercially available CMOS/CCD sensors.

The JPEG compression algorithm is comprised of the following steps.

- The first step is to prepare the image for compression. The picture in the RGB color format is converted to YCbCr colorspace. The YCbCr model has three channels namely, Luminance(indicated by Y), Chroma Blue(indicated by Cb) and Chroma Red(indicated by Cr). The reason for this is that the human eye is more receptive to luminance than chrominance. The Cb and the Cr channels are then down-sampled which results in loss of data. Since the maximum amount of data is in the luminance part, it is not downsampled and the channel data is retained without any downsampling.
- The output image is then split into blocks of size 8×8 . It is divided into blocks of 8×8 because there will be less variation in this region

of the image and this can be utilized to compress the image as much as possible.

- After this, the Discrete cosine transform is applied to these blocks of data to obtain the DCT coefficients for different frequencies. The idea behind the DCT is that by knowing the coefficients of different frequency components, it would be possible to reconstruct the image block. This is illustrated in Figure 2.9.

$$S_{i,j} = \frac{1}{4} * C_i * C_j \sum_{x=0}^{x=7} \sum_{y=0}^{y=7} P_{x,y} * \cos\left(\frac{(2y+1)*i*\pi}{16}\right) * \cos\left(\frac{(2x+1)*i*\pi}{16}\right) \quad (2.5)$$

where $P_{x,y}$ is the pixel value at the location x, y and C_i and C_j can be calculated using the equation 2.6.

$$C_i = \begin{cases} \frac{1}{\sqrt{2}} & \text{if } i = 0 \\ 1 & \text{otherwise} \end{cases} \quad (2.6)$$

- The next step is the lossy part of the JPEG compression which involves quantization of the data. In this process the coefficients obtained are quantized using a 8×8 quantization matrix. The quantization process is illustrated by equation 2.7.

$$B_{j,k} = \frac{S_{i,j}}{Q_{j,k}} \quad (2.7)$$

This quantization matrix varies from sensor to sensor depending on the manufacturer. However, the matrix is such that the DC component would be retained and the higher frequency components are rounded off to zero. This quantization factor also controls the quality of compression and higher the value of elements in quantization table, lower the value of compression. If you multiply the quantization table by a large quantization factor, you would lose the higher frequency components and would only retain the DC component(given by $S_{0,0}$) and lower frequency components. Many CMOS sensors allow the modification of quantization scaling factor.

- After this the coefficient data is converted from 8×8 to a 64×1 vector and the Huffman encoding scheme is used to encode the data. This does not lead to any loss of data and the process is completely lossless.

The entire JPEG compression process is shown in Figure 2.8. The process is followed in the reverse order in order to obtain back the original RGB image and is supported by all image viewing software.

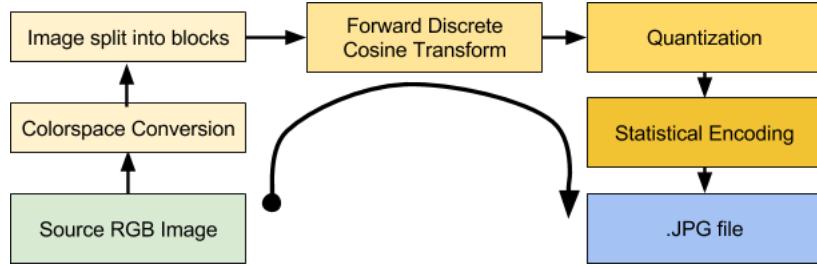


Figure 2.8: Steps involved in JPEG Compression[4]

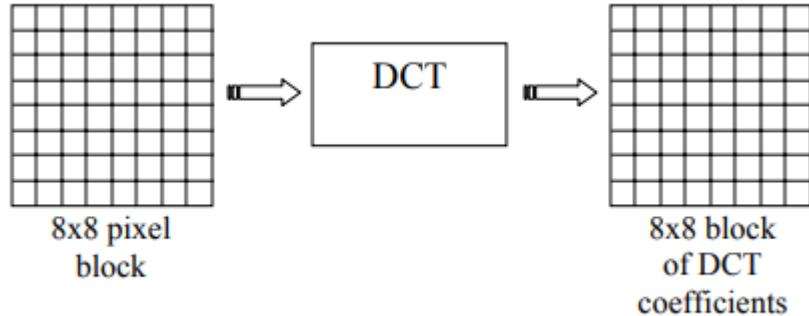


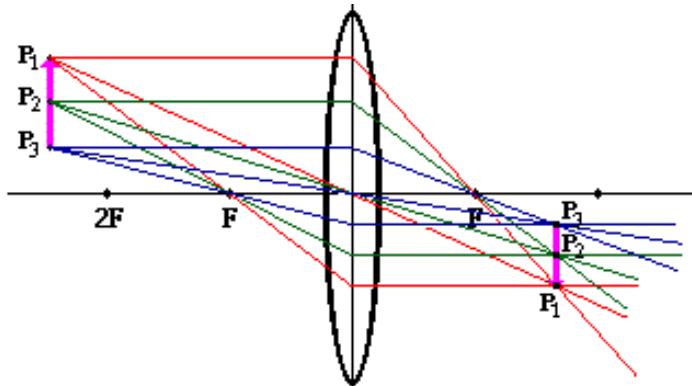
Figure 2.9: DCT involved in JPEG[40]

2.4.3 Masks and Reconstruction Algorithms

The main aim of designing a lensless camera is that it would help reduce the size of the camera considerably. In a lensed camera, light emanating from multiple-points in the object would intersect to form the image of the object. This is illustrated in Figure 2.10a. The focal length of the lens involved primarily determines the thickness of the camera(See Figure 2.10b). In a lensless imaging system, the lens is replaced by means of a mask(series of pinholes arranged in a periodic manner). This is illustrated in Figure 2.11.

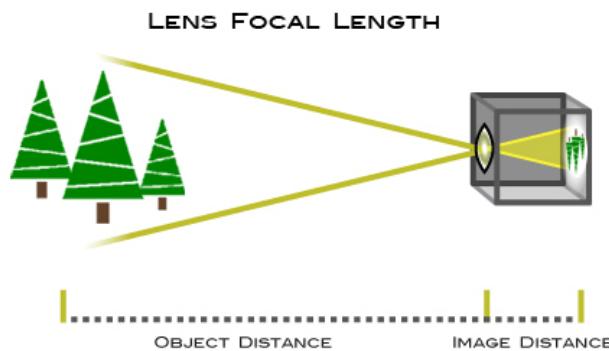
The simplest lensless imaging system is the pinhole camera. However, since the quality of the image depends on the size of the pinhole, that restricts the amount of light that can enter the imaging system. Lenses were introduced to focus the light from distant objects onto a film or a sensor. In the absence of a lens, the sensor would record the average intensity of the light entering it. This is also seen in the experiments which are described in the upcoming chapters. The difference between pinhole, lensed and a mask-based camera is shown in Figure 2.12.

In the 1960s, Fernimore and Canon introduced Fresnel Zone Plates for a “large aperture, high-resolution camera with neither refracting or reflecting components”[20]. The Fresnel zone plate is defined such that the radius of



All the rays of light emanating from each individual point on the object will refract and intersect at a single point in space. An image is created - the image is merely a replica or reproduction of the object.

(a) Image Formation in a lens-based camera[5]



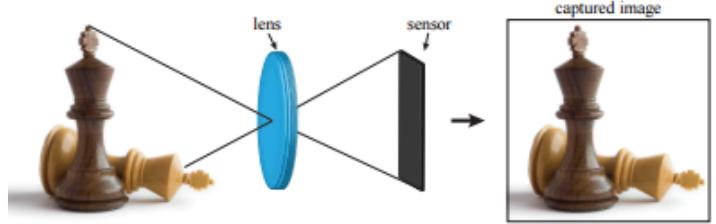
(b) Image Distance dictated by focal length [12]

Figure 2.10: Lens-based Camera

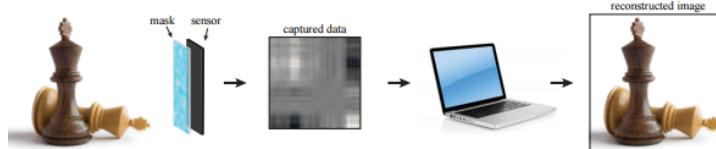
the n^{th} zone is given by

$$r_n = r_1 \sqrt{n} \quad (2.8)$$

An example of Fresnel Zone plate is shown in Figure 2.13a. Fresnel Zone Plates can be used in the places of lenses to produce images because FZPs produce images at multiple higher order foci depending on the type of Fresnel plate used. The Fresnel zone plates have a transmittance(refers to the ratio of light that is entering versus leaving the mask) of exactly 50 percent. It is always desirable to have an optical system with ideal system point spread function(SPSF). The point spread function describes the response of an optical system to a point source. It can also be called as the impulse response of the optical system. The ideal point spread function of an optical system would be a Dirac-delta function. However, in order to obtain such response with a Fresnel zone plate, it would have to be infinite. So, different forms of



(a) Conventional Lensed Imaging



(b) Lensless Imaging

Figure 2.11: Difference between lensed and lensless imaging methods[19]

	Pinhole camera	Lens-based camera	Mask-based camera
Light throughput	Low (~F/22)	High (~F/1.8)	High (~F/2.54)
Fabrication	Requires post-fabrication	Requires post-fabrication	Direct fabrication
Thickness	~10-20mm	~10-20mm	~10-500μm
Infrared and thermal	No wavelength limitations	Costly optics	No wavelength limitations
Cost	\$	\$\$	\$
Curved or flexible geometries	Infeasible due to limited field of view	Infeasible due to rigid optics	Adaptable to curved and flexible sensors

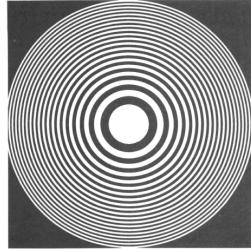
Figure 2.12: Comparison between different types of cameras[13]

coded-apertures were developed to overcome the limitations associated with Fresnel zone plates.

Coded aperture cameras extend the pinhole camera concept replacing the single aperture with a mask containing multiple apertures. The first developed coded aperture cameras were used in imaging X-Ray sources due to the difficulty involved in focusing light from X-Ray sources[20]. Since a single pinhole limits the amount of light imaged by the sensing element, it was replaced by many holes, called the aperture so that overlapping images are formed on the film. The recorded image will have no similarity with the source and a digital processing is required to reconstruct the source image or the object. The recorded image is mathematically modeled as a collection of overlapping shadows as described by the following equation[19][20]

$$I = M * O + e \quad (2.9)$$

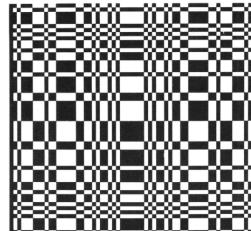
where I represents the image formed on the sensor, M represents the mask



(a) A twenty ring Fresnel Zone Plate



(b) A 60*60 Random Array



(c) A 61*59 Uniformly redundant array

Figure 2.13: Masks developed initially for lensless imaging[20]

pattern, O represents the irradiance vector or the object and e represents the noise. The $*$ operator represents the convolution operation between the mask and the object. The coded aperture increases the flux that falls on the detector and this leads to an increase in the SNR. The SNR can be as large \sqrt{N} , where N represents the number of holes in the aperture[20]. The increased SNR comes at the cost of computational decoding for the image. We can obtain the actual object image O using the inverse of the mask function. An ideal point spread optical function would produce a Dirac-delta response $M * M^{-1}$. In 1968, Dicke and Ables[20] introduced random arrays as an alternative coded aperture imaging method. The mask consists of randomly positioned holes in an opaque surface. An example of a random array is shown in Figure 2.13b. The total open area may or may not be equal to the amount of opaqueness. The image produced by random arrays are decoded digitally using auto-correlation analysis of the encoded images[20]. Like Fresnel Zone Plates, the random array also exhibits an ideal response when the size of the array is infinite which is

practically impossible. A new-class of apertures called uniformly redundant arrays(URAs) was developed over the disadvantages associated with random arrays. The uniformly random arrays exhibit a pattern that follows the equation 2.10[27]. The URA have a dimension of r by s with $r - s = 2$. The equation 2.10 takes $I = \text{mod}_r i$ and $J = \text{mod}_r j$ (i and j represent the array index position in x and y).

$$M(I, J) = \begin{cases} 0 & \text{if } I = 0 \\ 1 & \text{if } J = 0 \ \& \ I \neq 0 \\ 1 & \text{if } C_r(I)C_s(J) = 1 \\ 0 & \text{otherwise} \end{cases} \quad (2.10)$$

where $M(I, J)$ represent the values of the mask at co-ordinates I, J . A value of 1 indicates that mask is open at that point and a value of 0 indicates that the mask is closed. C_r is given by equation 2.11.

$$C_r(I) = \begin{cases} 1 & \text{if there exists an integer } x \text{ such that } 1 < x < r \text{ such that } I = \text{mod}_r x^2 \\ -1 & \text{otherwise} \end{cases} \quad (2.11)$$

The matrix used for deconvolution(given by equation 2.13) is given by the equation 2.12. This kind of array produces an ideal point spread function. The point spread function of different masks discussed above is shown in Figure 2.14.

$$G(I, J) = \begin{cases} 1 & \text{if } M(i, j) = 1 \\ -1 & \text{if } M(i, j) = 0 \end{cases} \quad (2.12)$$

$$O = I * G \quad (2.13)$$

It can be seen that the Uniformly redundant arrays would offer the best performance and would produce the ideal point spread function. The direct inversion by deconvolution with inverse works when the object is against a dark background with negligible diffraction effects(for example, in the X-Ray Spectrum). However, in the later studies[22], it can be seen that equation 2.9 no longer holds in the visible light spectrum involving extended-object scenes and direct Fourier/deconvolution based reconstruction methods would fail. This is also observed in the simulation studies described in the upcoming chapter. In order to solve the problems associated with reconstructing extended object scenes in the visible light spectrum, a new class of separable Doubly Toeplitz mask was developed by Michael Et al. [22]. These classes of masks retain their properties even in the presence of diffraction and extended-object scene based scenarios. The doubly Toeplitz-masks are expressed as a product of two independent vectors A and B .

$$M(i, j) = A(i)B(j) \quad (2.14)$$

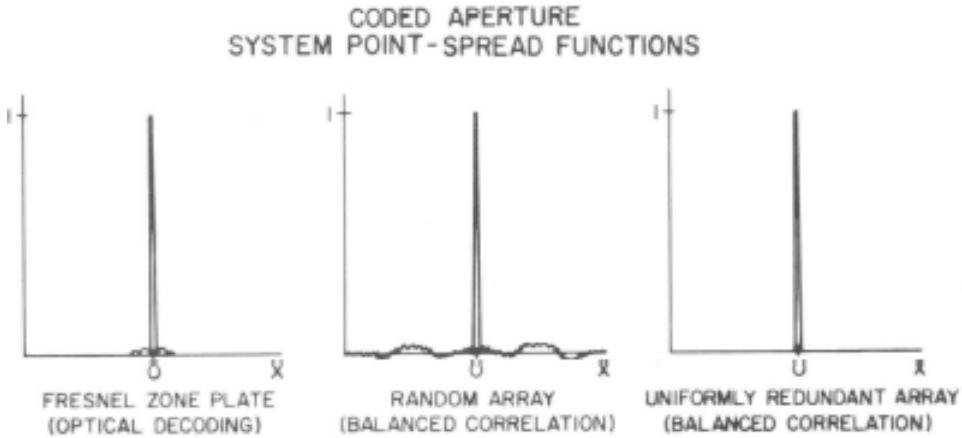


Figure 2.14: Point Spread function of different masks[27]

If the mask can be expressed in the form of two independent vectors, then the equation 2.9 can be re-written in the form:

$$I = M_A O M_B^T \quad (2.15)$$

The matrices M_A and M_B are toeplitz meaning they follow the form:

$$M = \begin{bmatrix} A_1 & A_2 & \cdots & A_N & 0 & 0 & \cdots & 0 \\ 0 & A_1 & A_2 & \cdots & A_N & 0 & \cdots & 0 \\ \vdots & \cdots & \cdots & \cdots & \cdots & \cdots & \cdots & \end{bmatrix}$$



Figure 2.15: An example of Doubly-Toeplitz Mask[22]

Previous studies[22][19][13] has proven that it would be possible to perform lensless imaging in the visible light spectrum for real-life object scenes. The detailed solution and modeling of the computational algorithm would be discussed in the next chapter. This kind of mask would be ideal for our application. There is also another class of masks with hexagonal shapes[30][25] which have been used for coded aperture imaging. However, these have not been studied since they offer no specific advantage compared to other masks discussed above.

Chapter 3

Simulation of Reconstruction Algorithm

3.1 Mathematical Model

This chapter will describe how the system can be mathematically modeled and how the mask for the lensless imager was chosen. MATLAB has been used for the purpose of simulating the algorithms. A major portion of the MATLAB code for the mathematical model described in this chapter was developed by Ph.D. student Yifeng Shao at Optics Research Group. We present this model to give the reader an idea of the computational algorithm involved in lensless imaging and to understand the work described in the subsequent chapters. As mentioned in the previous chapter the lensless system can be modelled as,

$$I = M * O + e; \quad (3.1)$$

where O refers to the object scene, M represents the mask function and I represents the image formed on the sensor. We can convert the equation 3.1 to fourier domain and express it as

$$F(I) = F(M)F(O) \quad (3.2)$$

$$F(O) = \frac{F(I)}{F(M)} \quad (3.3)$$

$$O = F^{-1}\left(\frac{F(I)}{F(M)}\right) \quad (3.4)$$

Equation 3.4 is the simplest possible computational inversion of the scene from the sensor. However, this method has a limitation of assuming periodic behaviour of object and infinite sensor size. This method cannot be used for imaging extended object scenes with finite sensor sizes. Hence, we need to use other methods to improve our solution and use it for extended object

scenes. The convolution representation given by equation 3.1 can also be expressed in simple matrix multiplication terms(given by equation 3.5)[22].

$$I1 = M'' O1 \quad (3.5)$$

where $I1$ and $O1$ are 1-dimensional vectors obtained by concatenating the rows and columns of I and O .

$$I1_{c_I \times i+j} = I_{i,j} \quad (3.6)$$

$$O1_{c_O \times i+j} = O_{i,j} \quad (3.7)$$

r_I, c_I, r_O, c_O denote the number of rows and columns of the sensor image and the object respectively. The matrix M'' basically has shifted rows of the first row of M'' . The first row of M'' is constructed from the mask M by taking each row of M , concatenating it with zeros till the vector reaches the size c_O . A vector of size c_O is constructed for each row and concatenated together to get the vector for the first row of M'' . The matrix $I1$ is a matrix of size $r_I c_I \times 1$, the matrix M'' is a matrix of size $r_I c_I \times c_O r_O$ and $O1$ is matrix of size $c_O r_O \times 1$. The solution is obtained using regularized normal equations:

$$O1_{\text{Guess}} = (M''^T M'' + \alpha^2 1_{r_O \times c_O})^{-1} M''^T I1 \quad (3.8)$$

where $1_{r_O \times c_O}$ represents the identity matrix used for regularizing the equation, remove the zero eigenvalues and make the matrix invertible. The size of the object contributing to the image sensor will be $r_O = r_M + r_I - 1$ and $c_O = c_M + c_I - 1$ pixels. The inversion given by equation 3.8 will take an extremely long amount of time to solve even using conventional PCs as the inversion can take as long as 10^{18} operations for a megapixel image. The number of operations are given by equation 3.13[22].

$$N_{\text{Operations}} \propto (r_O c_O)^3 \quad (3.9)$$

Since a generalized mask equation is extremely time-consuming and difficult to solve, separable doubly Toeplitz masks were developed[22] to reduce the amount of computation. One main advantage of using this type of mask is that it can be expressed as the outer product of two independent vectors. A separable mask pattern is one in which the mask matrix M can be expressed in terms of a row and column vectors of size r_M and c_M respectively.

$$M = A(i)B(j) \quad (3.10)$$

Both A and B are 1-D vectors. The mathematical model is also changed as described by the equation 3.11. A non-separable mask is one which does

not follow this property. When the mask is separable, equation 3.5 can be simply written as a product of two doubly Toeplitz masks.

$$I = M_A O M_B^T \quad (3.11)$$

The matrices M_A and M_B are Toeplitz and are of the form given by equation 3.12.

$$M = \begin{bmatrix} A_1 & A_2 & \cdots & A_N & 0 & 0 & \cdots & 0 \\ 0 & A_1 & A_2 & \cdots & A_N & 0 & \cdots & 0 \\ \vdots & \cdots \end{bmatrix} \quad (3.12)$$

The inversions and the multiplication is going to take a lot less time as r_M and c_M are way smaller than r_O and c_O respectively. The number of operations are given by equation 3.13[22].

$$N_{Operations} \propto (r_I c_O)^3 + (c_I c_O)^3 \quad (3.13)$$

Table 3.1: Table indicating the rows and columns used for simulation

Matrix	Rows	Columns
Mask Size, M	$r_M = 1024$	$c_M = 1024$
Image on Sensor, I	$r_I = 512$	$c_I = 512$
Object Area, O	$r_O = r_M + r_I - 1$ $= 1535$	$c_O = c_M + c_I - 1$ $= 1535$
Left System Vector, A	$r_M = 1024$	1
Right System Vector, B	1	$c_M = 1024$
Left Toeplitz Matrix, M_A	$r_I = 512$	$r_O = 1535$
Right Toeplitz Matrix, M_B	$c_I = 512$	$c_O = 1535$

3.2 Improved Mathematical solution and simulation

We can improve the solution since a separable mask follows the equation 3.11. The same improved solution has been used in [22]. We can express equation 3.11 as shown in equation 3.14.

$$M_A^T I M_B = (M_A^T M_A) O (M_B^T M_B)^T \quad (3.14)$$

We multiply the left and right system matrices to obtain square symmetric matrices. The problem is that they are not invertible, due to the presence of zero eigenvalues. So, the parameters α_A and α_B are added to remove the zero eigenvalues and make them invertible. The final solution will be given by the equation 3.15.

$$O_{Guess} = (M_A^T M_A + \alpha_A^2 \mathbf{1}_{r_O})^{-1} M_A^T I M_B (M_B^T M_B + \alpha_B^2 \mathbf{1}_{c_O})^{-1} \quad (3.15)$$

The separable mask simulation was carried out as shown in Figure 3.2. We can generate different types of masks by simply changing the base vector that is used for generating A and B . We generate A and B by interpolating smaller random vectors. The smaller the random vector, the closer the mask elements. The base vectors are created by generating a random vector of a smaller size(given by simulation variable $Nxm0$ and $Nym0$) and then setting elements above 0.5 to 1 and elements less than 0.5 to 0. These vectors are interpolated to a larger vector of sizes $r_M \times 1$ and $c_M \times 1$. By simply changing the size of the base vector used for interpolation, we can generate different shapes of Doubly-Toeplitz masks with the same property. In the simulation, the size of the base vector that is used for interpolating to the bigger mask changes. This leads to different masks being generated. The shape of the mask is simpler when we use a smaller vector for interpolation to get a bigger mask. The transmittance of the masks(ratio of open to closed area in the mask) varies between 20 to 25 percent. All the masks offer the same quality of reconstruction in the simulation. The different masks obtained by using different vectors for interpolation is shown in Figure 3.1. The masks generated using vectors of size 16, 32 and 256 is shown in Figure 3.1a, 3.1b, 3.1c. Intuitively, by changing the size of the vector used for interpolation, we can basically change the feature size of the mask. A base vector of smaller size generates a mask where the subsequent binary value comes at a greater distance than the one with a larger base vector.

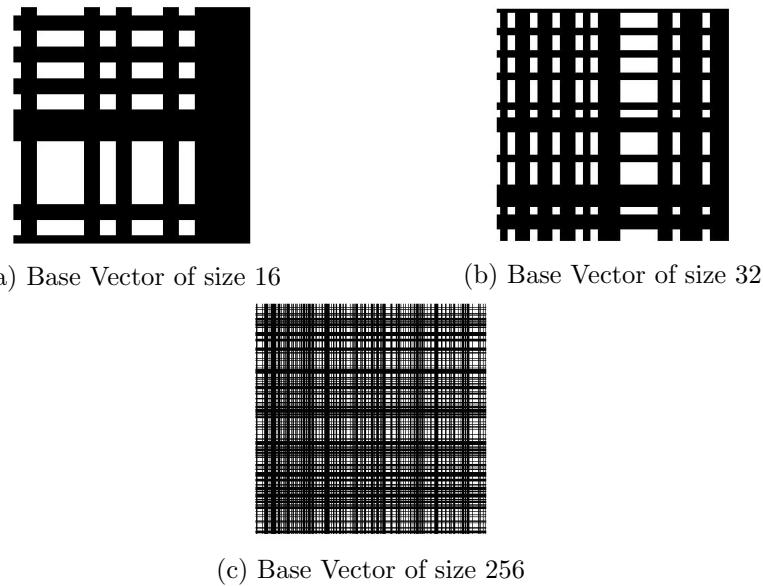


Figure 3.1: Different separable masks generated by using different vector sizes for interpolation of A and B . This produces different masks with the same property but different feature sizes.

In order to start with the mathematical modeling process and to imitate the sensor data and reconstruction, a reference image is needed. For that, it was decided to use the full moon image captured by the Apollo 11 space craft[3]. Since the satellite is going to be pointing towards astronomical objects like the earth and the moon, it was decided to crop out a portion of the full moon image(See Figure 3.4). The simulation is done under the assumption that the camera is enclosed in a box-like structure and light from a specific region of the earth/moon would reach it and the sensor size is finite. The image was converted to gray and scaled down from 0 to 1 and is displayed in the `bone` colormap format available in MATLAB as the colormap would display the minute variations in the reconstructed image. The mask is then convoluted with the object image(both the mask and image matrices are padded with zeroes to size $r_O \times c_O$). The obtained sensor image is cropped to fit a finite sensor size($r_I \times c_I$). The mask shown in Figure 3.1c is used for the simulations. This is illustrated in Figure 3.4. The simulation is performed with and without diffraction effects. The simulation parameters are shown in Table 3.2.

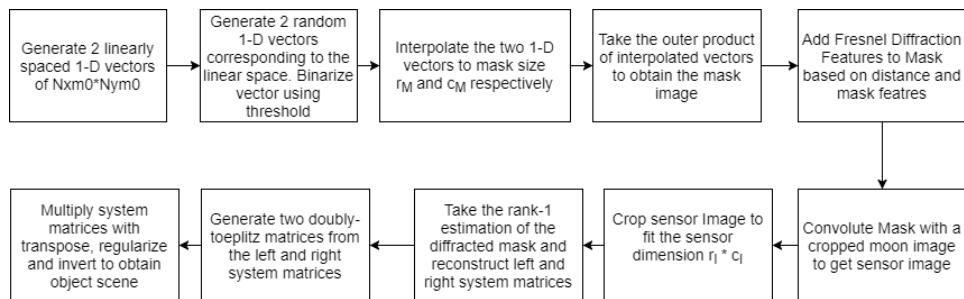


Figure 3.2: Simulation-Flow separable mask

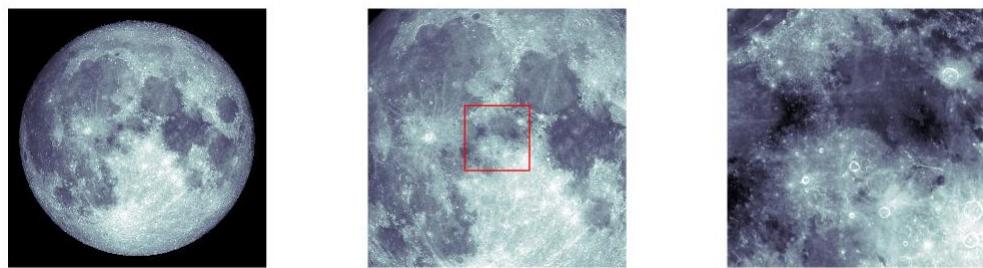


Figure 3.3: The first image is the original image of the moon as taken by Apollo 11 spacecraft. The second image indicates the cropped region and the third image indicates the region that is used for the simulation.

Table 3.2: Simulation Parameters

Pixel Size	$2.2\mu m * 2.2\mu m$
Sensor Size	$512 * 512$ pixels
Mask Size	$1024 * 1024$ pixels
Mask Sensor Distance	5 mm

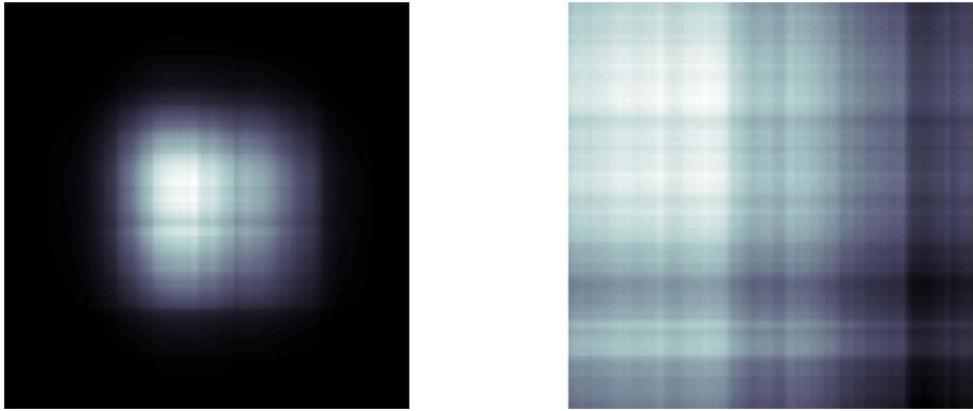


Figure 3.4: The first image indicates the sensor image if the sensor plane was infinite. The second image indicates the cropped sensor image that would be formed on an actual finite sensor size(cropped).

It can be seen from figure 3.2 that there is an additional step apart from the mathematical model involved in the simulation process. It is the rank-1 estimation of diffracted matrices. In this step, we perform Singular Value Decomposition(SVD) on the diffracted matrices to obtain M_A and M_B . Now let us see what is singular value decomposition. Singular value decomposition(SVD) is a mathematical tool that would enable us to express any matrix of the form $M_{m \times n}$ in the form given by equation 3.16[35].

$$M_{m \times n} = U_{m \times r} S_{r \times r} (V_{n \times r})^T \quad (3.16)$$

where r represents the rank of the matrix M , m and n denote the size of the matrix respectively. A doubly toeplitz mask in the presence of diffraction effects can be decomposed into U and V which is basically the left and right system vector of the diffracted mask. We can estimate the rank-1 estimation of a matrix by taking the first row and column of U and V and multiplying them as shown in equation .

$$M_1 = U_1 S_1 (V_1)^T \quad (3.17)$$

One of the main advantages of using a doubly Toeplitz mask is that it is decomposable into a single rank matrix with and without the effects of diffraction. The other rank-components are negligible even in the presence

of diffraction. This is an important property that must be kept in mind which will be used for various experimental purposes. Fresnel diffraction features are added to the mask since the distance between the mask and the sensor lies in the Fresnel diffraction region. The Fresnel diffraction modeling is described in the appendix section of the report. Diffraction causes the mask to become non-binary. In the simulation, we use SVD on the diffracted mask, take the rank-1 estimate of the mask. The U_1 and V_1 will represent the left and right system matrix of the diffracted mask. The obtained single dimensional U_1 and V_1 of the diffracted mask will be converted into Toeplitz matrices and inverted using equation 3.15. The decomposition of the diffracted and non-diffracted separable mask into a 1-rank matrix (with other components negligible) was also verified in the simulations. The difference between diffracted and non-diffracted separable mask is shown in Figure 3.5.

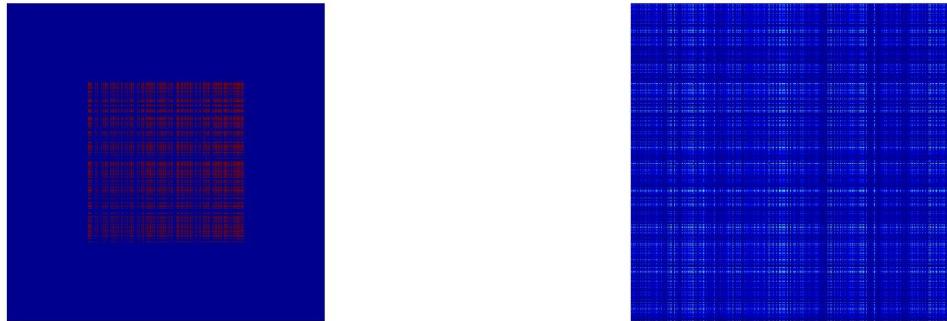


Figure 3.5: The mask on the left indicates undiffracted mask and the mask on the right indicates the diffracted separable mask

The reconstruction error is given by the equation 3.18.

$$PSNR = 20 \log\left(\frac{N * \max(O)}{MSE}\right) \quad (3.18)$$

where

$$MSE = \frac{1}{mn} \sum_{i=1}^{i=N} \sum_{j=1}^{j=N} [O(i, j) - O_{guess}(i, j)]^2 \quad (3.19)$$

where O_{guess} indicates the reconstruction and O represents the original object.

It can be seen from Figure 3.6 that even in the presence of diffraction it would be possible to obtain reconstructions using equation 3.15 by using a separable mask. The regularization constants α_A and α_B were found out by testing for different possible values and the values which gave the best possible reconstruction were chosen. It was seen that the separable mask would work best for our application and we can safely assume that we can

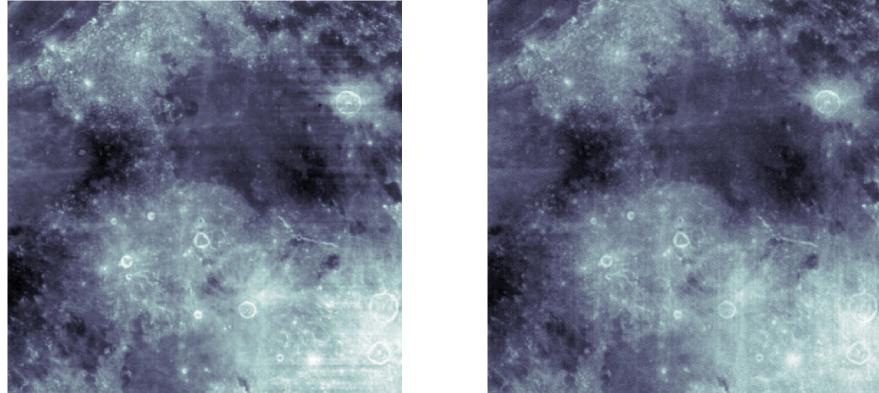


Figure 3.6: The figure shows the reconstruction with and without fresnel diffraction effects for a separable mask using equation 3.15. We are able to obtain $\text{PSNR} = 57.85$ without diffraction effects. It can be seen that we can obtain reconstructions even in the presence of diffraction effects with $\text{PSNR} = 57.93$

use these masks to obtain reconstructions for extended object imaging in the visible light spectrum as the diffraction effects have also been taken into account.

Chapter 4

Implementation

In this chapter, we will be discussing the implementation of hardware and software of the camera that would be used for subsequent experiments. The main specifications of the chosen cameras are shown in Table 4.1. These specifications are taken from the sensor data sheet and the camera manual provided by the vendors of the camera[16][17][37][39].

4.1 Embedded Software of Camera

One of the main reasons behind choosing the OV2640 and OV5642 CMOS sensors is that they already have a ready electronic interface that can be used to interface with standard 8-bit/16-bit microcontrollers. Arducam is an open source camera that comes along with open-source hardware and software that is needed to capture images using the CMOS sensor. Arducam is a platform that provides the hardware and software components necessary to interface OV2640 and OV5642 sensors with the conventional microcontroller platforms such as Arduino. One of the core components in every camera made by Arducam is that there is a component called Arduchip[15]. It is a basically an Altera MAXII CPLD EPM240 processor that facilitates DMA memory transfer between the camera memory module and components such as microcontroller and thereby helping to reduce the development time for special applications such as space where the only computational resource that would be available are low power computing platforms such as microcontrollers with only synchronous serial interfaces such as I2C, SPI, etc.

However, using the camera comes with its own advantages and disadvantages. The main advantage of using this platform is that the platform has open-source libraries that could be used to interface with Arduino which contains ATMEGA328P, an 8-bit microcontroller. In space missions, it would not be possible to send high-powered microprocessors, and a microcontroller is used as the processing platform for various subsystems. Arducam has

Table 4.1: Key Specifications Specifications of sensors Chosen

Specification	OV2640	OV5642
Voltage Level	3.3/5V	3.3/5V
Frame Buffer Size	384 KB	8MB
Active Pixel Array Size	1600×1200	2592×1944
Camera Dimensions	34mm × 24mm	34mm × 24mm
Sensor Dimensions	5725 μm × 6285 μm	6945 μm × 6695 μm
Pixel Size	2.2 μm × 2.2 μm	1.4 μm × 1.4 μm
Weight	20 grams	20 grams
Operating Temperatures	-10°C to 55°C	-10°C to 55°C
Electronic Interfaces Needed	SPI, I2C	SPI, I2C
Dynamic Range	50 dB	68 dB

standard software libraries that can be used to interface with Arduino making the cumbersome and lengthy job of writing an interface software to a CMOS sensor way more easier. A disadvantage of the hardware module is the onboard memory that it has to capture an image. The OV2640 Arducam mini camera module can capture up to 1600×1200 resolution images with or without any form of compression. However, due to the limitation of the onboard OV2640 FIFO memory AL422B, it would be possible to capture only compressed images and not full resolution RAW images. The AL422B on-board FIFO has only 384KB of memory and that is not enough to obtain a full-resolution RAW image. One of the other disadvantages is that custom code needs to be written to obtain various controls that we need for our camera. We have to write our own camera control software if we need to control factors such as exposure time, ISO, etc. as the default software uses automatic exposure control to enhance the image quality. The camera module architecture is shown in Figure 4.1. The OV5642 offers a greater flexibility in terms of memory as it has a larger FIFO Buffer(8 MB). Arducam has also provided APIs that can control the exposure of OV5642.

The system for experiments is as shown in Figure 4.2. The Arduino is connected to the sensor directly through an I2C interface. Using the I2C interface it possible to set registers that control the functioning of the camera such as the output format, digital signal processing, etc. SPI interface is used to transfer the image data from the camera module to the Arduino. The Arduino upon receiving the image data either writes it to an SD card or sends it to the software on the PC through the USB connection. The software flow is shown in Figure 4.3. We use the same software flow for both the CMOS sensors as the APIs are designed for use with many sensor models. The same set of libraries can be used for different CMOS sensors by

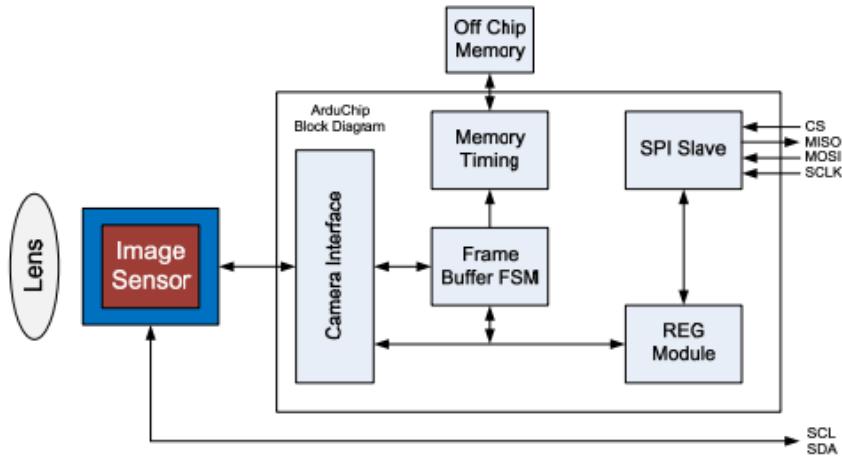


Figure 4.1: Camera Architecture of Arducam Mini OV2640 Camera Module[17]

simply adding some preprocessor directives to a `memorysaver.h` header file provided in the open-source library. To see the images on the PC, the vendor has provided a host PC software(not open source) and firmware which uses USB-UART to transfer images from the Arduino to PC. The firmware could be modified to ignore certain commands coming from the PC and using this we were able to modify the camera settings to our advantage.



Figure 4.2: Implementation Setup

One of the important factors that need to be controlled in camera is the exposure time. The Arducam libraries provide APIs for 10 different exposure levels for the OV5642 sensor. However, no such APIs are available for OV2640. Since OV2640 consumes lower power, it was decided to start the experiments with this camera. So, we need to write custom software to control the exposure level of this camera. The Arducam APIs used for the software are shown in Table 4.3. The details of more APIs can be found in the software application notes[18]. The default camera settings were used with only modifications to exposure in the case of OV2640 module. The CMOS sensor can be directly accessed using `wrSensorReg16_8`, `wrSensorReg8_8` functions which provide I2C bus access to the CMOS sensor.

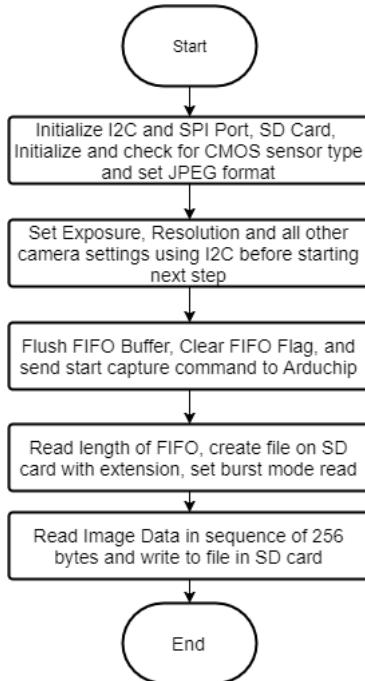


Figure 4.3: Software Flow used for image acquisition from CMOS sensors

4.1.1 Exposure Control of OV2640

In order to do experiments, it was required to control the exposure of the camera. In the default driver that was provided by the vendor, the exposure was automatically set using the Automatic Exposure Control (AEC) feature in the sensor. So, a modification was needed in the driver software. Fortunately, the driver is open source and there were libraries that could assist in setting the onboard registers through the I2C interface on the Arduino. First, let us have a look at how exposure control works in an OV2640 camera. All rolling shutter image sensors including OV2640 expose the sensor one-line at a time i.e. pixels in the same line are exposed at the same time and different pixels in different lines are exposed at a different time.

So, the minimum exposure time would be one line time and the maximum exposure time would be the frame time. This is illustrated in Figure 4.4. By default, the pixel clock is set at 36MHz. We can calculate the minimum line time using the following equation:

$$\text{Minimum Exposure Time} = \frac{1}{\text{Pixel Clock}} * \text{Pixel Clocks per line}$$

As shown in Figure 4.5, one line consists of 1922 pixel clocks(1600 for pixel data and 322 clocks of horizontal blanking). So the minimum exposure time would be 53.39μseconds and the maximum exposure time would be the frame

Table 4.2: Details of Main APIs used

API	Function
<code>InitCAM</code>	Initialize Camera Module
<code>set_format</code>	JPEG and BMP output formats can be selected
<code>clear_fifo_flag</code> <code>read_fifo_length</code> <code>set_fifo_burst</code> <code>flush_fifo</code>	These functions are used to control the FIFO buffer, read the size of the image and to reset them when needed
<code>write_reg</code>	This function is used to write values to the specified register address on the Arduchip.
<code>wrSensorReg16_8</code> <code>wrSensorReg8_8</code>	These functions are used to set camera registers using I2C. The first function is used for 16-bit register addresses and the second function is used for 8-bit addresses
<code>OV2640_set_JPEG_size</code> <code>OV5642_set_JPEG_size</code>	These functions are used to set the resolution of the output image
<code>OV5642_set_Exposure_level</code>	This function is used to set the exposure level of the OV5642 CMOS sensor

time(multiply line time by $1200 + 44$ lines of vertical blanking) which would be 66.63ms[8]. In order to control the exposure of the camera, it is necessary to modify registers of address 4, 10, 13, 45(See Figure 4.6). So, these registers were modified according to the required exposure time value. The driver software on the Arduino was modified to obtain different exposure times. The images of a laser beam captured(with lens) with different exposure times using the software developed are shown in Figure 4.7.

4.2 Power Consumption of Sensors

One important aspect that also needs to be taken into account is the power consumption of the camera module(including the sensor, memory, voltage regulators, etc). Since, we have two camera modules, OV2640(low resolution, low power) and OV5642(high resolution, high power). It was decided to perform power consumption measurements for the sensors manually. In

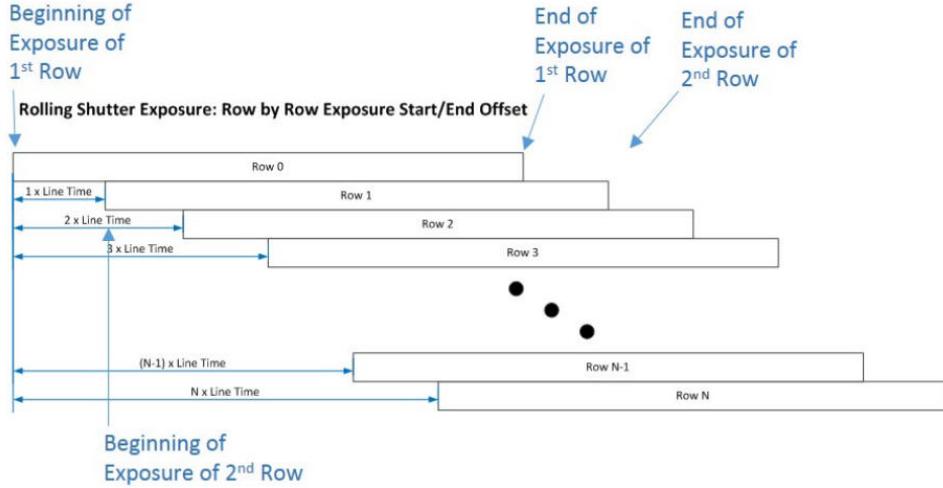


Figure 4.4: Rolling Shutter Operation on OV2640[8]

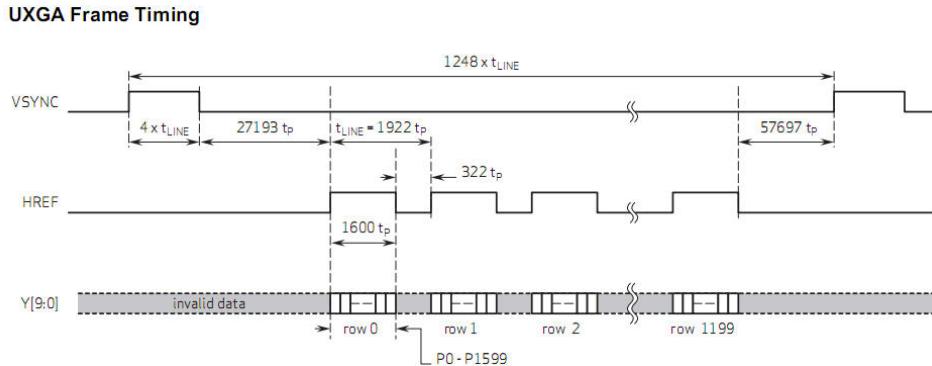


Figure 4.5: Shutter Timing Diagram of OV2640[8]

order to find the amount of power consumed, we connect a 1Ω resistor in series with the power line connecting the microcontroller and CMOS image sensor. The voltage measured across the resistor would be the current consumed by the camera sensors. The camera was operated in two modes: one in continuous “on” mode and the second mode was “on only when capture”. The second mode was activated clearing `GPIO_PWDN_MASK` when the camera is in use and set it once again once the camera is done taking the pictures and then saving it onto the memory card. This turns off the power supply lines from the Arduino to the when the camera is not taking pictures. The current consumption graph is shown in Figure 4.8.

It can be seen from Figure 4.8 that we can reduce power consumption by switching on the camera only when in use. The camera is operated in 5V mode. The current consumed by the camera is averaged and the measured power consumption is shown in Table 4.3. As expected, the higher resol-

Address (Hex)	Register Name	Default (Hex)	R/W	Description
13	COM8	C7	RW	Common Control 8 Bit[7:6]: Reserved Bit[5]: Banding filter selection 0: OFF 1: ON, set minimum exposure time to 1/120s Bit[4:3]: Reserved Bit[2]: AGC auto/manual control selection 0: Manual 1: Auto Bit[1]: Reserved Bit[0]: Exposure control 0: Manual 1: Auto
45	REG45	00	RW	Register 45 Bit[7:6]: AGC[9:8], AGC highest gain control Bit[5:0]: AEC[15:10], AEC MSBs
10	AEC	33	RW	Automatic Exposure Control 8 bits for AEC[9:2] (AEC[15:10] is in register REG45[5:0] (0x45), AEC[1:0] is in register REG04[1:0] (0x04)) AEC[15:0]: Exposure time $T_{EX} = t_{LINE} \times AEC[15:0]$ <i>Note: The maximum exposure time is 1 frame period even if T_{EX} is longer than 1 frame period.</i>
04	REG04	20	RW	Register 04 Bit[7]: Horizontal mirror Bit[6]: Vertical flip Bit[4]: VREF bit[0] Bit[3]: HREF bit[0] Bit[2]: Reserved Bit[1:0]: AEC[1:0] (AEC[15:10] is in register REG45[5:0] (0x45), AEC[9:2] is in register AEC[7:0] (0x10))

Figure 4.6: Registers to be changed to control exposure of OV2640[37][8]

ution camera OV5642 consumes more power than OV2640. Since OV2640 consumes lower power and is also of lower resolution(which implies lesser size of images), we proceed to continue with the next set of experiments using OV2640.

Table 4.3: Measured power consumption of Cameras only when “on only when capture”

Sensor	Power
OV2640	5V/93mA
OV5642	5V/233mA

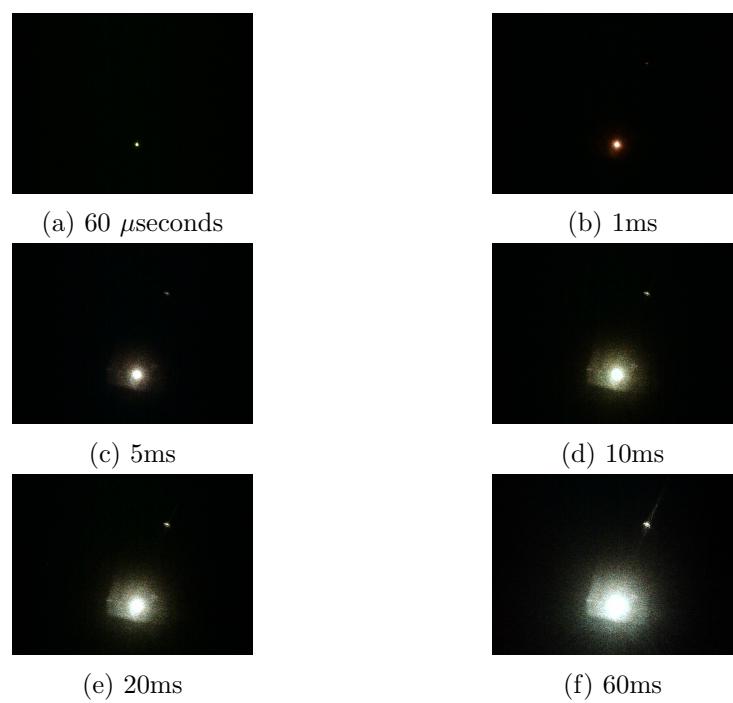
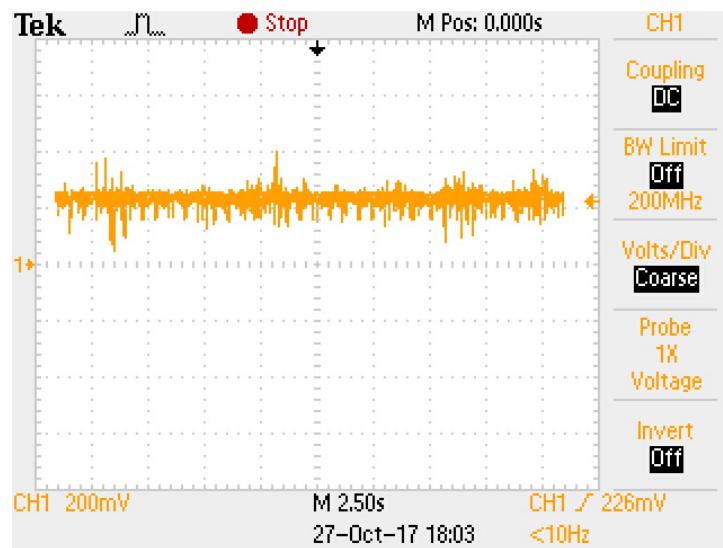


Figure 4.7: Images of a laser beam caught in different exposure times (with lens)



(a) Voltage across resistor when continuously on



(b) Voltage across resistor when using `GPIO_PWDN_MASK`

Figure 4.8: This figure shows the difference between keeping the OV5642 sensor module continuously on and using the `GPIO_PWDN_MASK`

Chapter 5

Experiment to determine Acceptance Angle of CMOS sensor

In this chapter, we will be discussing the experimental approach to finding the acceptance angle or the acceptance cone of the CMOS sensor. The acceptance cone primarily determines the field of view of the lensless imaging system. In the absence of lenses, the acceptance angle of the imaging sensor is determined by the acceptance angle of the micro-lens array on the surface of the image sensor. Hence, it is extremely important to determine the acceptance angle through an experimental approach. From this chapter onwards, all the experiments described are performed without the use of any lenses in front of the image sensors. Also, it must be noted that the terms CMOS sensor and image sensor are used in the place of each other and they both mean the same thing in our case.

5.1 Testing of Acceptance Cone of Sensor

5.1.1 Experimental Setup

A study conducted previously[42] has employed cat's eye reflectometer method using four spherical lenses to accurately measure the chief ray angle of a CMOS sensor up to 0.65° [42]. Apart from this, Armstrong Optical uses another complex method for measuring the chief ray angle or the acceptance angle[1]. However, our work employs a simpler method to measure the acceptance cone of a CMOS sensor without the use of any lenses. Our method uses a collimated laser beam(650 nm), a pinhole for finding the accurate center of the axis and a rotational stage(to measure angular rotation) to find the response of the sensor to light at different angles and in-turn the acceptance cone of the sensor. Figure 5.1 shows the experimental setup that

was made to measure the acceptance cone of the sensor. A collimated laser beam was reflected off a mirror and it is passed through a pinhole. The pinhole is mainly used to align the sensor with the beam. The pinhole produces a diffraction pattern that can be used to align the image sensor with the center of the beam. The difference in measurements with and without pinhole is shown in Figure 5.2.

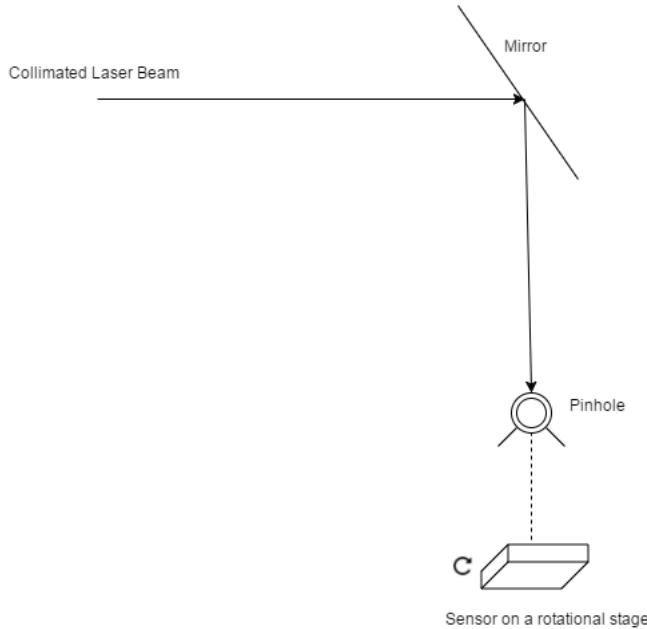


Figure 5.1: Experimental Setup for detection of acceptance cone



Figure 5.2: Images of a laser beam caught with and without pinhole

The pinhole cannot be used to measure the acceptance cone of the sensor because the waveform from the pinhole is a linear combination of different plane waves from different angles. Hence, this measurement was done without a pinhole. In order to measure the acceptance cone of the sensor, it is necessary to identify a portion of the image that can be taken as a reference to plot the variation in the signal measurement. It was assumed that the maximum point in the image can be taken as the signal. Since

there was too much variation in the intensities measured, it was decided that we would average the 10 images in each angular position to reduce the signal noise. The maximum value in the image was taken and normalized and the measurements were repeated from -45° to $+45^\circ$ for 10 sets. The data from the red channel is analyzed. The exposure value was chosen such that the output does not saturate(does not reach 255) for any value in the image(See Figure 5.3). The maximum value in the image versus the angle is plotted. The ideal exposure value would be the one in which the signal does not saturate and there is still some room for additional signals. This is also indicated in Figure 5.3.

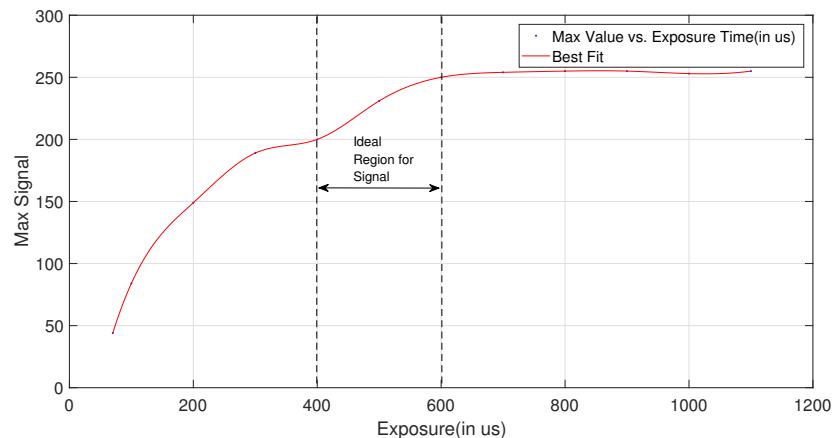


Figure 5.3: Response for different Exposure values in microseconds

The obtained response curve for red channel is shown in Figure 5.4. The normalized signal values are plotted with the standard deviation obtained for each angle are indicated with the use of an error bar. The best obtained curve fit is also plotted.

The initial observations from the results obtained are:

- There seems to be a very large standard deviation for each angle.
- There seems to very sharp outliers at -5° and -10° which is a highly unexpected behavior.

These two observations point to experimental error. The error in the experimental results could be due to the following reasons:

- **Error introduced due to the translation of the rotational stage**
: In order to make sure that the beam always hits the stage is translated if the beam does not hit due to the translation of the sensor away from the beam. This introduces an additional angular error which is not taken into account in the initial experiment. So, the stage was

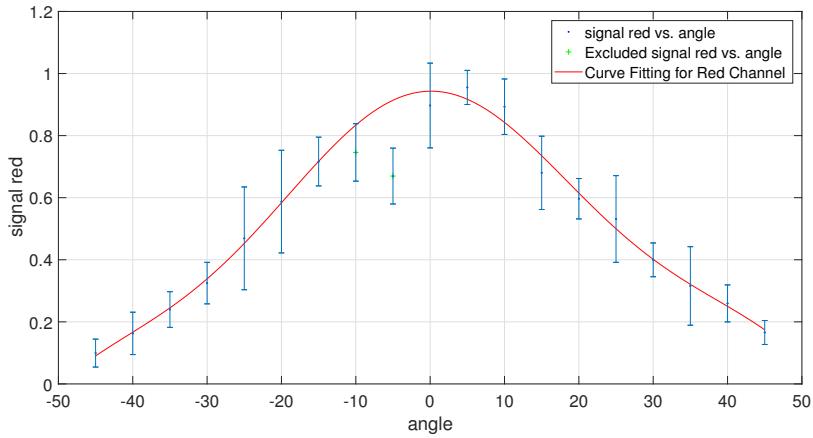


Figure 5.4: Response for Red Channel in Initial Experiment

calibrated using the pinhole. If the sensor is exactly at the center of rotation of the rotational stage, the laser beam must always hit the same position of the sensor no matter what the rotational angle may be. The position of the sensor on the rotational stage was calibrated such that the signal(image with pinhole) obtained always remained at the center of the sensor.

- **Improper Reference Signal from Image :** At times, it was observed that the maximum point in the image occurs at different and unexpected points that are outside the beam. This also leads to different parts of the signal being measured each time. The outliers in the results could also mean that. An example average image in which the maximum is obtained at the end of the beam is shown in Figure 5.5. The point from where the signal is obtained is marked using a yellow star in the Figure 5.5.
- **Large Variation in the intensity of output image :** It was noticed that there was a huge variation in intensity for subsequent measurements at the very subsequent instants. This variation in the output is the cause of the large standard deviation in the result. Initially, I thought that this could be due to a relatively low exposure time(as lower exposure could lead to more output noise) or due to the variation of intensity of laser beam. Increasing the exposure time did give lower variations but the problem was traced to the automatic gain control(AGC) in the OV2640 image sensor. The amplifier gain of each pixel was adjusted automatically and this led to different intensities in subsequent readings. After this feature was turned off by modifying the driver software using I2C, it seemed that the variation in the output was no longer there.



Figure 5.5: Improper Reference Point for Signal

- **Unexpected Colors in the output image :** An unexpected feature in the image is seen in each measurement. The unexpected feature is the presence of green and blue colors of the laser beam. Since the laser beam is red with an almost constant wavelength in the red visible light region, the output of green is unexpected. This was very strange and upon studying the sensor, it seemed that the sensor had an automatic white balance(AWB) feature of OV2640. This white balance feature assumes a “gray” world(wherein the average of all colors in the world is gray)[38] which is not true in our case. The difference in the output is with and without AWB is shown in Figure 5.6. Even after this adjustment, there seems to be a slight tinge of green at negative angles where the beam seems to “dim” out. Even after trying out a variety of different settings this green could not be eliminated and could be due to Black Level Calibration in the sensor. The function of Black Level Calibration (BLC) is to produce accurate color in the dark area of the picture. There is no mention of how to turn off this feature in the datasheet or the application notes of this sensor. The vendor of the camera did not provide any information on how to turn off this feature. Hence, it was assumed that the sensor does not make any modifications to the red channel in angles where the signal “dims” out.

5.1.2 Improved experiment

As mentioned in the previous experiment, the stage was calibrated such that the sensor remains at the center of rotation of the rotational stage.



Figure 5.6: Images of a laser beam caught with and without pinhole

The reference signal was chosen such that the same point of the beam is always measured. In order to make sure that the same point of the beam is measured with and without pinhole, the coordinate of the central diffraction pattern is stored for different angular positions for -45° to $+45^\circ$ and the reference signal is taken from this point. In order to detect the central region in the output, a function called `imfindcircles` is used[7]. This function finds circles in an image using circular Hough transform. The readings for a specific angle are averaged and a logarithmic function is applied which is then passed to the `imfindcircles` function to detect the brightest possible circle with a radius of 3 pixels (This value was tuned such that the central portion is detected with 100 percent accuracy). The detection process using this method provided 100 percent accuracy for detection of the center of the central fringe pattern coordinate. This is illustrated in Figure 5.7. The Automatic gain controls and Automatic White balance features of the CMOS sensors were turned off by using suitable register settings mentioned in [37]. The Arduino was programmed to set the register values using I2C. The exposure was set at $500\mu\text{s}$ based on the exposure graph (See Figure 5.3).

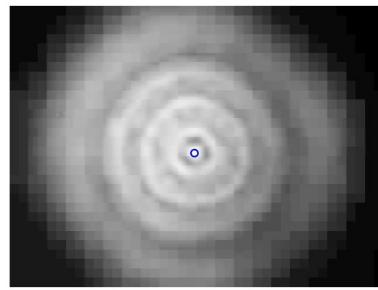


Figure 5.7: Coordinate Detection for central region signal detection

In the first step of the experiment, the rotational stage is rotated from -45° to $+45^\circ$ with pinhole and the coordinates of the central diffraction pattern is stored in a variable. In the second step of the experiment, the pinhole is removed and the signal is taken for different angles from the center coordinates measured using the diffraction pattern. This will ensure

that we measure the same part of the beam every time we take a signal for measurement. After this, the signal is taken with a different offset (from the central diffraction pattern) in the X-direction to make sure that all the pixels behave in the same manner. The graphs for 100 different pixel positions in X-direction from the central position is shown in Figure 5.8. From this graph, it can be seen that all the pixels in the same line exhibit the same behavior with a slight shift in angular position peak. In figure 5.9, the response for different pixels in the Y-direction is shown. It can be seen that there is a wider variation in the curve peak position. It can also be seen that all the pixels follow the same pattern with a slight shift in the peaks.

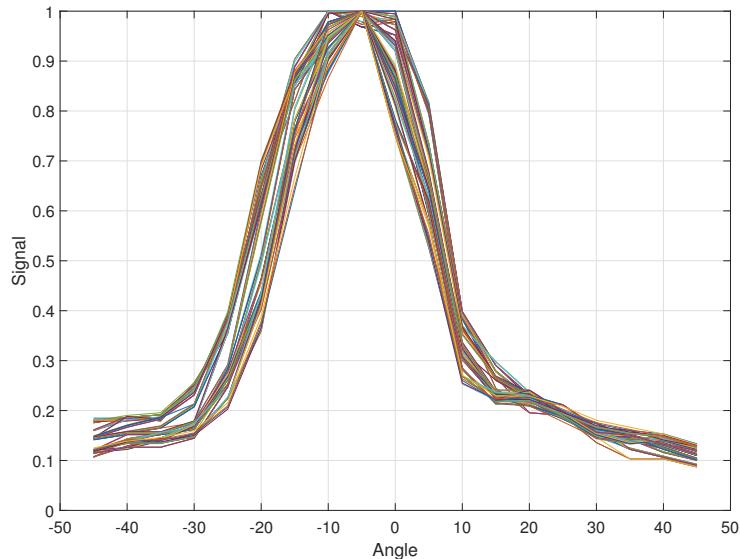


Figure 5.8: Response for 100 different offset pixel positions from central diffraction pattern in X-direction

The peak positions for different pixel offset positions in the X and Y direction is shown in 5.10. It can be seen that pixels in the same neighborhood have the same peak angular positions. The shift in peak is seen as we move across the detector. The peak angular position for different pixel positions is shown in Figure 5.10. This can be attributed to the non-uniformity in the laser beam that is used for measuring the response of the pixels.

The experiment is repeated for 10 times and the response is plotted only for the red channel as we have only red frequency light hitting the sensor beam. The final result after solving the problems mentioned in the previous section is shown in Figure 5.11. There is less overlap in the subsequent angles and no points are excluded in the curve fitting process. The maximum standard deviation was reduced from 16 percent for the angular position -

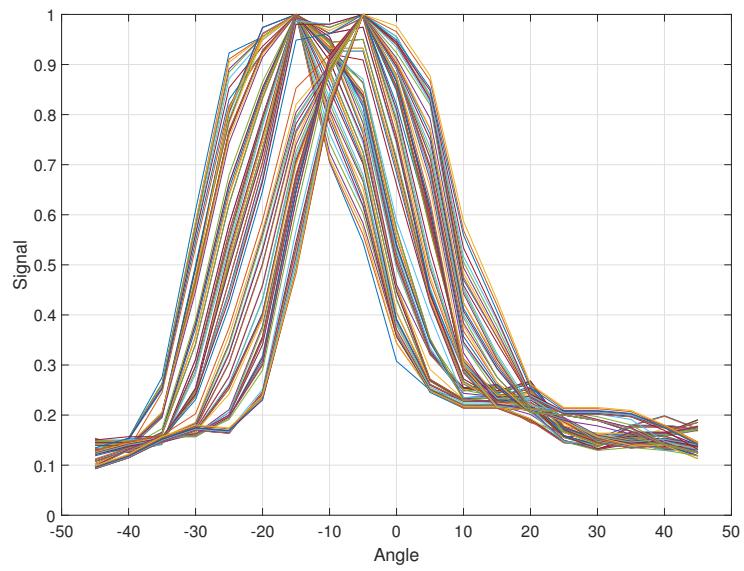


Figure 5.9: Response for 100 different offset pixel positions from central diffraction pattern in Y-direction

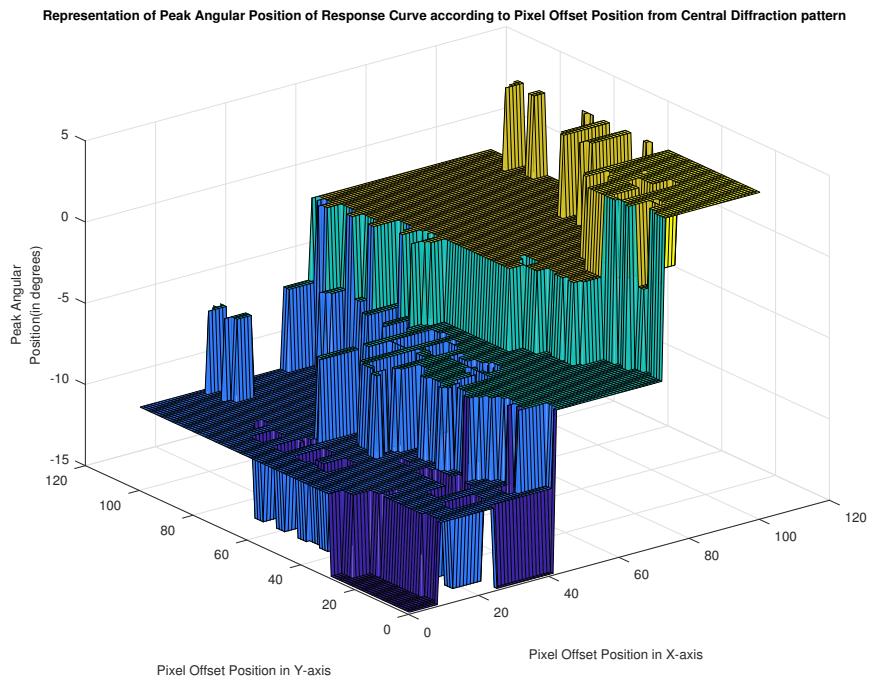


Figure 5.10: Peak Angular Positions for different Pixels

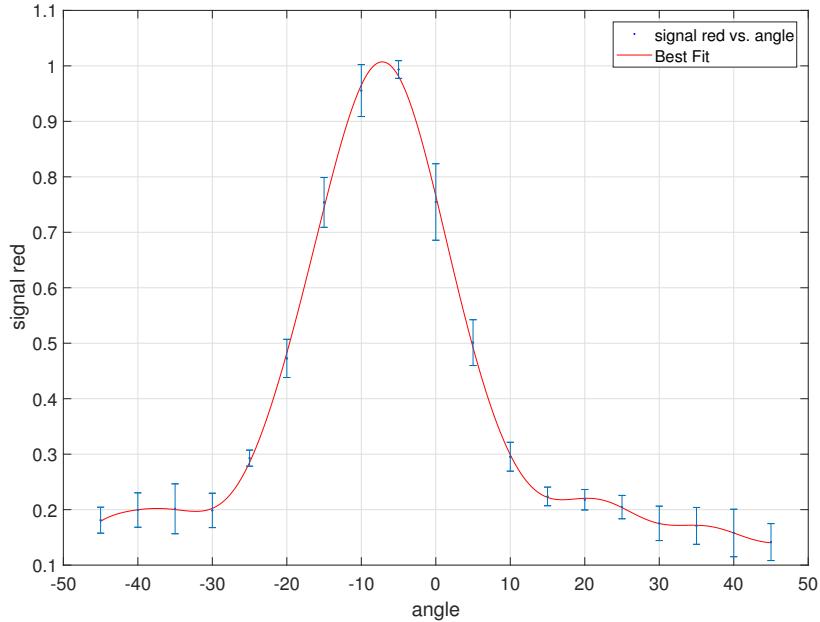


Figure 5.11: Finalized Red Channel Response for Different Data Sets

20(See Figure 5.4) to 6 percent for angular position 0(See Figure 5.11). The peak of the curve is shifted towards -5° because the maximum position of the laser beam occurs at -5° position of the rotational beam. The graph data needs to be incorporated into the simulation to see the effect of the acceptance cone of the sensor on the image reconstruction. This will be discussed in the subsequent section.

5.2 Adding to Simulation

The curve data that was obtained in the previous experiment was incorporated into the previously obtained simulation results. In order to incorporate the data, we need to generate a 2-dimensional matrix that would simulate the behavior of the acceptance cone effect on the reconstruction. Since the behavior will be exhibited in both the horizontal and vertical directions, the 1-D curve was converted into 2-D by multiplying itself with its transpose. This would generate a circular symmetric matrix that would generate the effect of the acceptance cone in both the horizontal and vertical directions. This is shown in Figure 5.12. We increase the effective interest area from 512×512 to 1024×1024 to visually see the number of pixels lost due to the acceptance angle effects. The mask size is changed accordingly to suit the image size. This matrix is multiplied with the original image to simu-

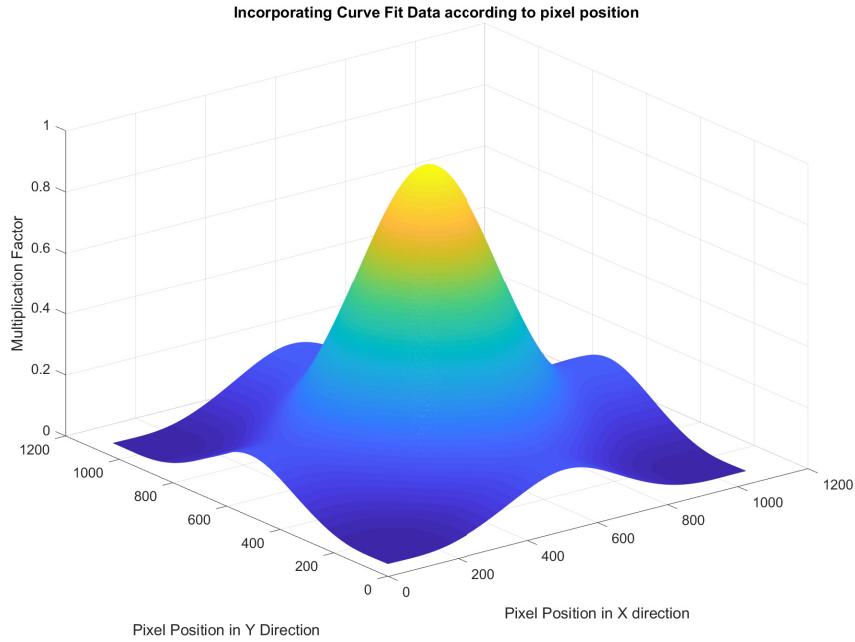


Figure 5.12: Fitted Curve Data into simulation

late the effect of angle acceptance on the image reconstruction. This was tried with the simulation results that simulate the effects of diffraction to simulate as close to a real world. The source image, the reconstruction only with diffraction effects and the reconstruction with diffraction and acceptance cone is shown in Figure 5.13. It can be seen that reconstruction with diffraction effects lead to a slight loss of detail. Once we incorporate the effects of acceptance cone into the simulation, it can be seen that only a portion of the original image can be reconstructed which is indicated by the square box in Figure 5.13. This would be the actual field of view in the real world. In order to find the angular field of view, the positions of the square box must be correlated with the fitted matrix curve discussed. On doing this, it can be found that the area in the rectangular box corresponds to an angle of -21.7° to $+21.7^\circ$. The angular field of view in absolute terms will be 43.4° in the horizontal direction. The horizontal field of view and the vertical field of view can be considered to be equal since the pixel size of the CMOS sensor(OV2640) is the same in both directions.

A lens based system would have a larger field of view depending on the lens used. The OV2640 camera module by default comes with a 1.4-inch lens with a field horizontal and vertical acceptance angle of $70^\circ \times 63.7^\circ$ [16][14]. The lensless system would have a horizontal and vertical acceptance angle of view of $43.4^\circ \times 43.4^\circ$. This leads to a field of view reduction of 38 percent and 31.8 percent in the horizontal and vertical directions. The effective

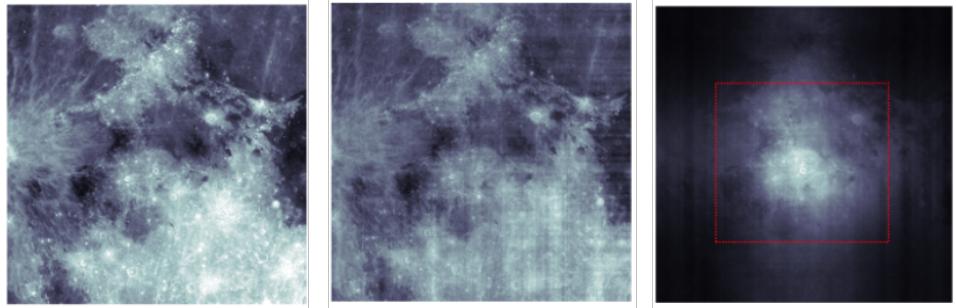


Figure 5.13: The image on the left indicates the original object image, the image in the middle indicates the reconstruction with only diffraction effects. The image on the right indicates both diffraction and acceptance angle effects. The red area indicates the effective amount of pixels that can be used.

pixels that can be used by the camera is reduced to 48 percent meaning that only 48 percent of the total number of active pixels can be used for effective imaging. This is the trade-off that we need to face when we reduce the size of the camera by removing the lenses.

5.3 Actual Field of View and Spatial Resolution Calculations

In this section, we will be discussing how we can calculate the field of view of the camera from the experiment and will also perform spatial resolution calculations. This will give us an idea of how the camera will perform when used in an actual space application. The spatial resolution can be calculated using equation 5.1.

$$d_s = \frac{d_p}{d_t} * d_h \quad (5.1)$$

The calculated spatial resolutions(d_s) based on mask-sensor distance(d_t) and the height of the satellite(d_h) from the earth is shown in Figure 5.14. It can be seen from the graph that as we increase the mask-sensor distance, we can attain better spatial resolutions that can represent the ground data better. the best spatial resolution is obtained when the mask-sensor distance is the greatest(i.e 10 mm) and when the satellite is as close to the earth(350 kilometers). The best possible spatial resolution can be achieved at a height of 350 kilometers which would be 7.7 meters per pixel for a mask-sensor distance of 10 mm. A mask-sensor distance of 5 mm would provide 15.4 meters per pixel at the same height. It can be seen that if we make the camera thicker, we can get better spatial resolutions. The figure 5.14 is

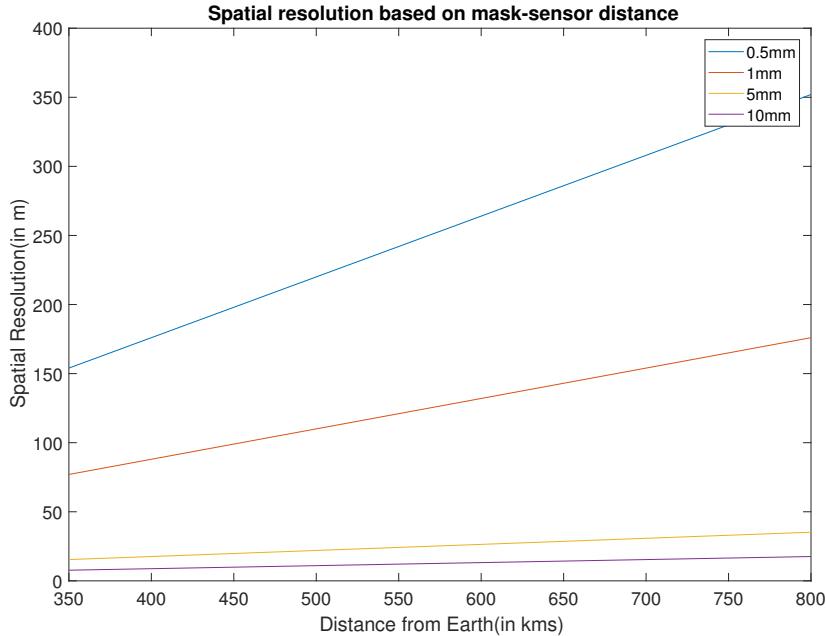


Figure 5.14: Relation between Spatial resolution and mask-sensor distance for sensor OV2640

calculated for a pixel size of $2.2 \mu\text{m} \times 2.2 \mu\text{m}$. The other sensor OV5642 can offer a better spatial resolution as it's pixel size is smaller $1.4 \mu\text{m} \times 1.4 \mu\text{m}$. The spatial resolution values will be scaled by the ratio of the pixel sizes.

The field of view of the camera can be calculated using the acceptance angle calculated from integrating the experimental and simulation results. The sensor OV2640 has an experimentally verified acceptance angle of $21.7^\circ(\theta_{cra})$. The field of view can be calculated using equation 5.2.

$$d_{fov} = 2 * d_h * \tan(\theta_{cra}) \quad (5.2)$$

The obtained calculation results are shown in Figure 5.15. It can be seen that maximum field of view can be obtained when the satellite is at a height of 800 kilometers from the surface of the earth. However, the spatial resolution as mentioned earlier will be lower at higher altitudes. A maximum field of view of 636 kilometers can be obtained at a height of 800 kilometers. The sensor OV5642 has an acceptance/chief ray angle of 23.6° as mentioned in its data sheet[39]. However, this claim has not been experimentally verified.

5.4 Spatial Light Modulators

A spatial light modulator (SLM) is an object that imposes some form of spatially varying modulation on a beam of light[11]. SLMs can be controlled

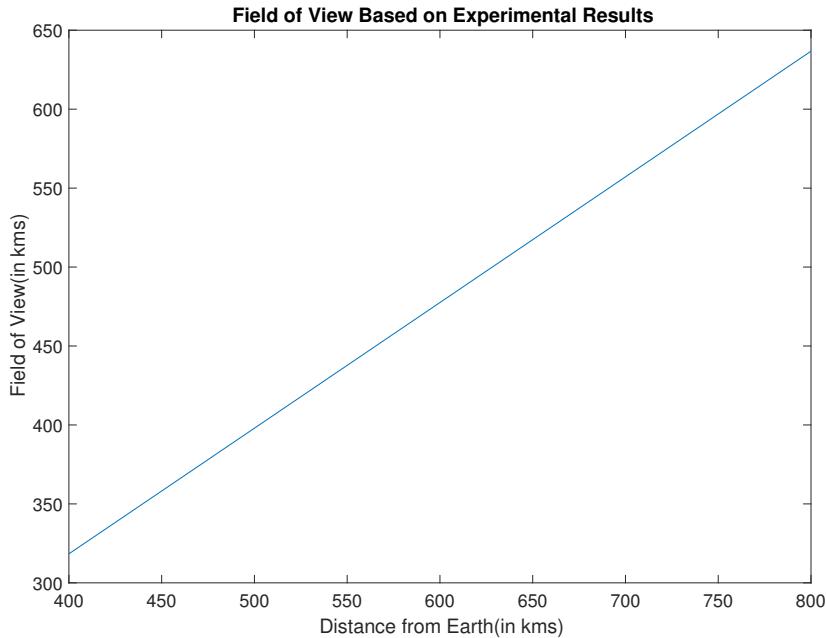


Figure 5.15: Field of View Calculation based on Experimental Results

by computer controlled software and it would be possible to generate patterns on the SLM that could modulate phase or the intensity of the beam or both simultaneously. An advantage of using an SLM over designing a lithographic mask is that it would be possible to test out different designs of masks quickly in order to find out an optimal mask configuration that would be suitable to our setup. In our design of the lensless imager, it must be possible to block and allow light in a certain binary pattern. A transmissive SLM would suit the purpose of simulating different mask patterns. For this purpose, a Holoeye LC2012 SLM was used. The SLM has a pixel area of 1024×768 and a pixel pitch of $36 \mu m$.



Figure 5.16: HoloEye LC2012 SLM

Chapter 6

Experimentations with SLM

6.1 Initial Experiments to image mask

The experimental setup consists of a coherent laser beam, two mirrors, a spatial filter, a collimator lens, LC2012 SLM and finally an OV2640 CMOS sensor. The experimental setup is shown in Figure 6.1. The collimator lens and the spatial filter make the beam parallel and remove unwanted random noise in the laser beam.

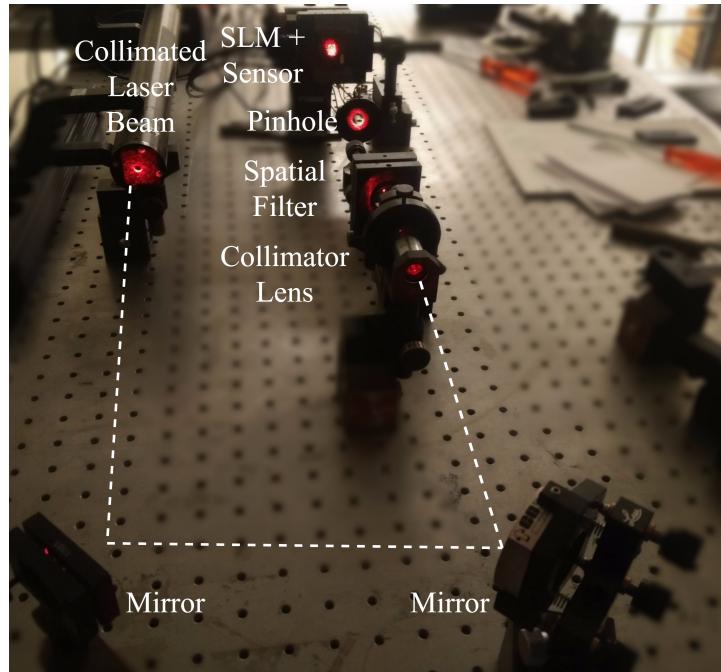


Figure 6.1: Experimental Setup to image mask

I started off the experiment with the setup shown in Figure 6.1. However,

when trying to take an image of the mask with the CMOS sensor, I faced multiple challenges along the way. The first challenge came in the form of the memory limitations of the camera module. The OV2640 camera module has only 384KB of memory which can store compressed JPEG images when imaging with the lens. The memory limitation of the camera does not come into effect when imaging with the lens as JPEG encoding is naturally designed for reducing the size of real-life artifacts and object scenes with a very high compression ratio. However, when using the same camera module, for lensless imaging, the size of the image easily exceeds the size of the FIFO buffer and the host software provided by the vendor is unable to read out the images. In order to overcome this challenge, I thought of increasing the extent of compression (with a trade-off of loss in quality) to image the mask. This can be done by changing the QSC register (quantization scale factor) [37] of the CMOS sensor. The default value of the quantization scale factor is 0C(hex value). This value was increased to 2F by setting the registers using I2C as mentioned for the previous acceptance cone experiments. The size of the image was successfully reduced and the host software was able to read out images. After this, the sensor was placed in front of the SLM and the experiments were continued. I started experimenting with the default masks provided by the SLM vendor before continuing onto the custom mask designed using simulations. The mask that was used is a binary axicon mask and binary mask which divides the SLM into two different halves. The figure of the mask is shown in Figure 6.2.

After overcoming this challenge I faced the second challenge wherein, the binary axicon mask was not visible and the central part of the sensor had saturated (whited out). This can be seen in Figure 6.3. It can be seen from Figure 6.3 that the binary axicon mask is not at all visible due to the saturation of the CMOS sensor in the central region. The horizontal mask is imaged as a vertical mask by the CMOS sensor as the SLM is oriented vertically against the CMOS sensor. Even in the horizontal mask, the central portion has saturated.

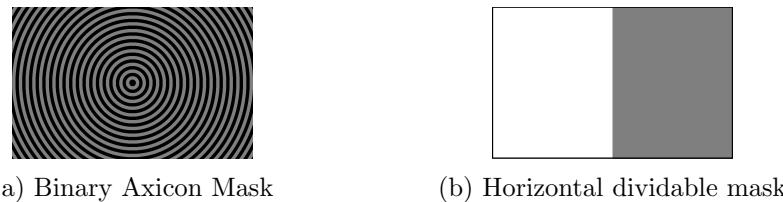


Figure 6.2: Binary Masks used for Test

In order to solve these problems, multiple changes were made to the way the experiment was conducted. To avoid saturation, the exposure time of the CMOS sensor was reduced to the least possible value ($70 \mu\text{seconds}$). Since this did not affect the image of the mask formed on the sensor, it was



(a) Binary Axicon Mask imaged by CMOS
 (b) Horizontal dividable mask imaged by CMOS

Figure 6.3: Binary Masks used for Test

decided to change the brightness and contrast levels of the SLM itself. The transmissive SLM acts as an LCD screen and thus it has its own brightness and contrast levels that affect the amount of light reaching the sensor. So, I decided to study the effect of the brightness and contrast of the image sensor. Also, two n.d filters were added to the setup that cut the intensity of light reaching the sensor by 75 percent. The SLM was placed approximately at a distance of 1 cm(10 mm) from the image sensor for these experiments. It could not be moved closer than 1 cm because the SLM is covered with polarizers to filter the light reaching the sensor and to prevent any damage to the SLM.

6.2 Effect of SLM brightness and contrast on CMOS sensor

The first set of experiments was conducted to see the effect of brightness and contrast of the SLM on the image formed by the CMOS sensor. For this, I thought of illuminating the CMOS sensor using the laser beam and then study the output image from the CMOS sensor for different gray levels on the CMOS sensor. The highest gray level(255) was chosen and the brightness/contrast levels were varied to see which brightness/contrast levels best represent the amount of light proportional to the grayscale levels of the SLM(i.e. maximum reduction in intensity). A gray level of 255 represents complete blocking of light and a gray level of 0 represents the complete passage of light. The binary mask should be translated to gray levels before we can put it on the SLM. So, we need to study the impact of brightness/contrast on the gray levels. The brightness/contrast levels could be varied from 0 to 64 on the SLM. All the readings were normalized with respect to 255 to see how the intensity drops with respect to grayscale levels. It can be seen from figure 6.4 and table 6.1 that there is a certain level of drop in intensity signal irrespective of the brightness levels. It can be seen from Figure 6.4 that the maximum brightness and contrast levels best reflect the gray levels of the SLM.

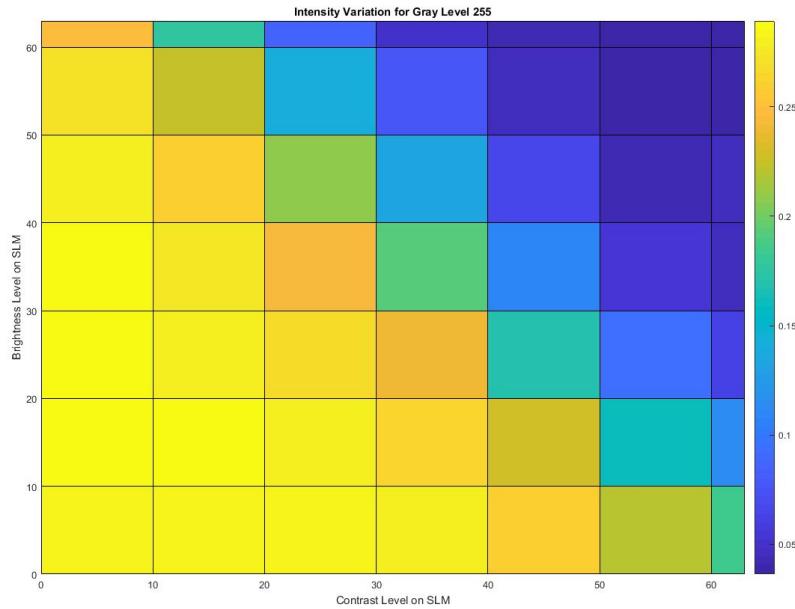


Figure 6.4: Effect of brightness and contrast on intensity for grayscale 255

Table 6.1: Attenuation Factors of gray level 255 with respect to gray level 0 for different brightness and contrast levels

C \\ B	0	10	20	30	40	50	60	63
0	0.9834	0.9941	1.3247	1.2975	0.9602	1.0882	0.81991	0.8124
10	0.9971	1.0161	1.2988	1.2161	0.8096	0.5931	0.4336	0.3780
20	1.011	0.9831	1.2162	1.5084	0.5896	0.3460	0.2686	0.2113
30	0.9966	0.9647	1.1133	0.8718	0.3898	0.2200	0.16253	0.1946
40	0.9841	0.9138	0.9454	0.4592	0.2239	0.1554	0.1627	0.14317
50	0.9350	0.7867	0.6462	0.2665	0.1593	0.1420	0.1296	0.1356
60	0.8626	0.6265	0.3937	0.2237	0.1418	0.1345	0.1327	0.1291
63	0.8188	0.7389	0.3334	0.2104	0.1375	0.1323	0.1385	0.1293

6.3 Effect of gray levels on CMOS sensor

From the experimental results mentioned in the previous section, it can be seen that the maximum brightness and contrast levels of the SLM provide the maximum attenuation in signals. So, these values were chosen and the grayness levels of the SLM was varied from 0 to 255 and study how the gray-

scale levels affect the amount of light passing through the SLM. The entire SLM screen is set to this grayscale level so that the entire sensor is modulated with the same intensity of light. The mean of the entire output image of the CMOS sensor is taken for plotting the signal and it is normalized with respect to the maximum reading and the graph is plotted. This is shown in figure 6.5. As it can be seen in the graph, the lowest point corresponds to an intensity reduction of approximately 88 percent. One important observation is that it is not possible to create a completely binary mask which blocks light as the maximum intensity reduction is only 88 percent. This will have an effect on the image reconstruction as it is assumed that the mask is completely binary.

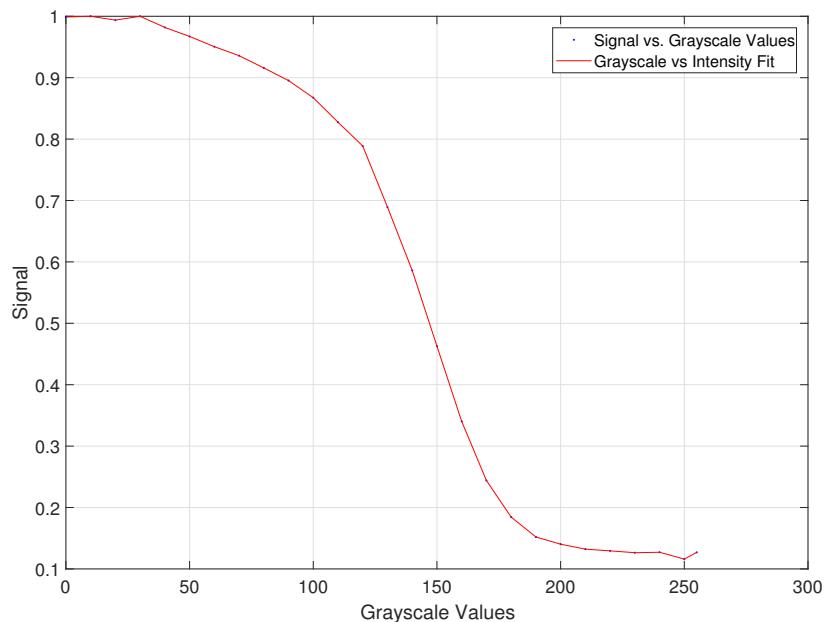


Figure 6.5: Grayscale vs intensity of light received by the CMOS sensor.

6.4 Imaging of Separable Mask using CMOS sensor

In the previous section, we discussed how the SLM brightness and contrast affect the mask visibility on the CMOS sensor. In this section, we keep the mask brightness and contrast at maximum possible setting and image the mask. A separable doubly Toeplitz mask is generated for the resolution of the SLM. The generated mask is converted to gray level 255 for regions that block light and gray level 0 for regions that allow light. The gray level mask is then programmed onto the SLM. As mentioned in the previous sections,

a doubly Toeplitz mask is one in which the row and column of the matrix can be expressed in the form:

$$M = A_{1024 \times 1} (B_{768 \times 1})^T$$

Like in the simulations, a linearly spaced random vector is generated for a specific length(N_{xm0}) and interpolated to the SLM screen length(1024×768). Two vectors are generated(keeping N_{xm0} and N_{ym0} constant) and the outer product of the vectors is taken to produce a mask that is same as the resolution of the SLM. We need to perform singular value decomposition on the output image from the CMOS sensor in order to make sure that the mask preserves the property of separability. Since the SLM is larger than the CMOS sensor, the sensor only images a particular portion of the mask and not the complete mask itself. The mask can be decomposed into a singular matrix value no matter which part of the mask is imaged by the sensor. This was also verified in the MATLAB simulations by cutting out different portions of the mask and testing for separability. The doubly Toeplitz mask generated and used for the experiments is shown in figure 6.6. The region marked in red will also exhibit only one singular value on performing SVD. SVD forms the basis of the mask imaging experiment. We

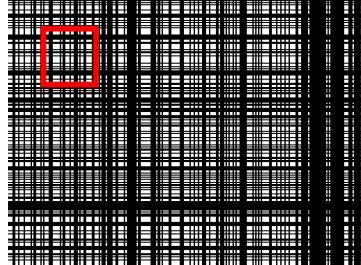


Figure 6.6: Doubly Toeplitz mask

image the mask using OV2640 and see whether the mask still exhibits the same property when imaged by the CMOS sensor. The image of the doubly Toeplitz mask imaged by OV2640 is shown in figure 6.7. As can be seen from the figure 6.7, the OV2640 produces a very poor image of the mask. This can be attributed to the poor quality of compression. The quantization factor increased during the previous experiments(see the first section in this chapter) in order to reduce the size of the image has reduced the quality of the output image. The change in the default quantization matrix and the modified quantization matrix that has been used for compression is shown below. The default quantization matrix has been modified so that the size of the image is within 384 KB. Without modifying the quantization scale factor,

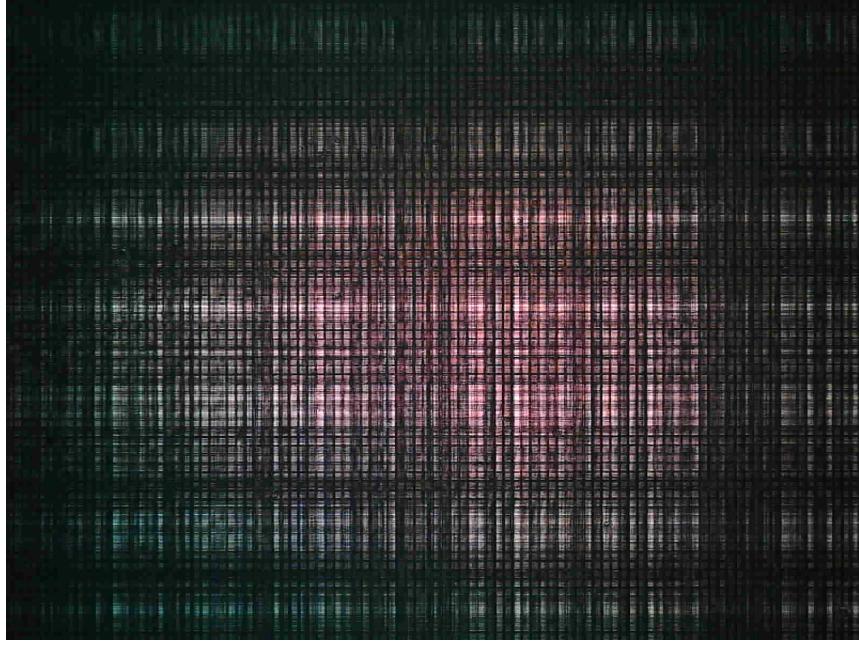


Figure 6.7: Doubly Toeplitz mask imaged by OV2640 after modification of Q-Table

it would not be possible to obtain an image using a mask-sensor setup using OV2640. From the modified Q-Table, we can see that the higher frequency components will be eliminated and the lower frequency components will be retained. The Q-tables were obtained using the `djpeg` program[24] on the output image sensors running on Linux.

$$Q - Default = \begin{bmatrix} 12 & 8 & 8 & 12 & 18 & 30 & 38 & 46 \\ 9 & 9 & 11 & 14 & 20 & 44 & 45 & 41 \\ 11 & 10 & 12 & 18 & 30 & 43 & 52 & 42 \\ 11 & 13 & 17 & 22 & 38 & 65 & 60 & 47 \\ 14 & 17 & 28 & 42 & 51 & 82 & 77 & 58 \\ 18 & 26 & 41 & 48 & 61 & 78 & 85 & 69 \\ 37 & 48 & 59 & 65 & 77 & 91 & 90 & 76 \\ 54 & 69 & 71 & 74 & 84 & 75 & 77 & 74 \end{bmatrix}$$

$$Q - Modified = \begin{bmatrix} 47 & 32 & 29 & 47 & 71 & 118 & 150 & 179 \\ 35 & 35 & 41 & 56 & 76 & 170 & 176 & 162 \\ 41 & 38 & 47 & 71 & 118 & 167 & 203 & 165 \\ 41 & 50 & 65 & 85 & 150 & 255 & 235 & 182 \\ 53 & 65 & 109 & 165 & 200 & 255 & 255 & 226 \\ 71 & 103 & 162 & 188 & 238 & 255 & 255 & 255 \\ 144 & 188 & 229 & 255 & 255 & 255 & 255 & 255 \\ 212 & 255 & 255 & 255 & 255 & 255 & 255 & 255 \end{bmatrix}$$

Based on the mask image and the quantization tables obtained, we can be sure that it would be impossible to obtain proper reconstructions using OV2640. So, it was decided to try whether other CMOS sensors would produce better quality pictures that would enable proper reconstruction. Based on the trade-off factors discussed previously, an OV5642 sensor was also bought in the case of any failure. Since OV2640 and OV5642 follow the same architecture and use the same open-source libraries, it was easy to port the embedded software from OV2640 and OV5642. Also, APIs are provided to control the exposure level of OV5642 in 10 possible steps. The exposure was set to minimum possible level as higher levels cause saturation of sensor data. The compression quality was set to High using APIs provided by Arducam. It was then decided to check the image quality on OV5642. The OV5642 has an advantage that it has a bigger active sensor array(2592×1944) and comes with a larger FIFO buffer(8MB). The CMOS sensor needs to be perfectly aligned and the perfect alignment would be given by the maximum singular value ratio. In order to position these sensors on the stage, a script was written that would calculate the singular values in real time. The tilt of the sensor was adjusted such that the ratio of the first component to the second component is maximum. It can be seen in figure

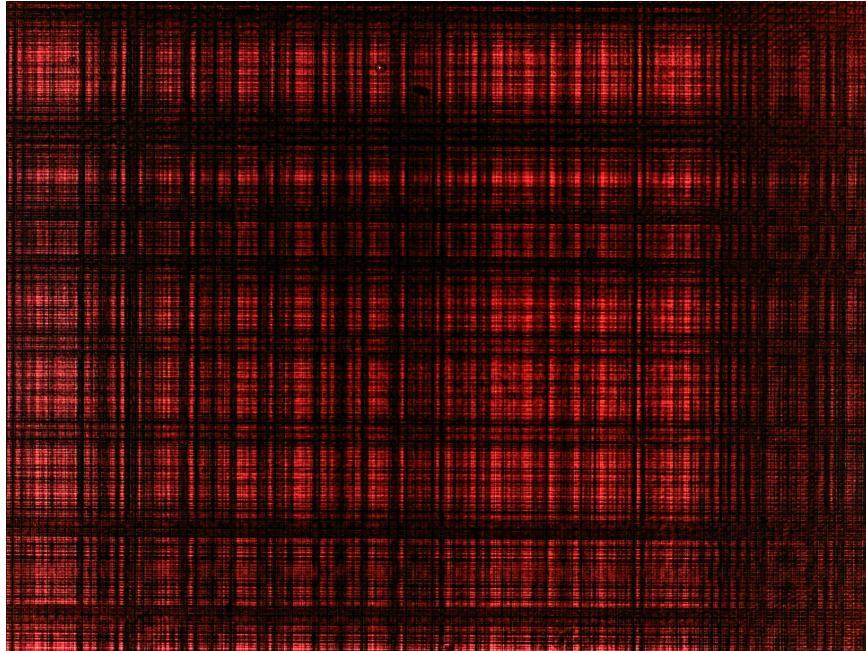


Figure 6.8: Doubly Toeplitz mask imaged by OV5642

6.8 that OV5642 produces a better image of the mask. In order to compare the performance of OV5642, another web camera(Microsoft LifeCam HD 3000) was disassembled and the mask was imaged(See figure 6.9). The

difference in redness is due to the saturation level adjustment on LifeCam. A lot of methods were tried to increase the ratio of the first to the second

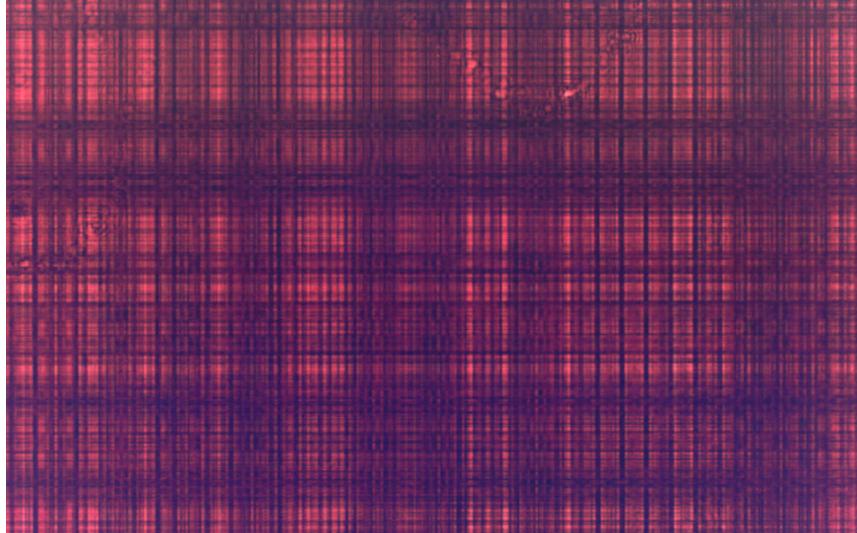


Figure 6.9: Doubly Toeplitz mask imaged by Microsoft LifeCam HD 3000

singular value. Firstly, I tried to capture the image without any mask and capture the noise. I subtracted the noise from the mask image. However, this did not lead to any change in the singular component values. I then tried median filtering the output to reduce the Gaussian noise effects and it increased the singular value ratio with all the CMOS sensors. This is shown in table 6.2. Table 6.2 was plotted from the average of images in a particular data set using the same masks. The red channel data and the grayscale image data from the mask image are used for SVD. It can be seen from the table that OV2640 provides a better singular value ratio than OV5642. However, the highest singular component does not at all represent the mask that is programmed into the SLM. So, OV2640 does not perform equivalent to OV5642 despite the higher ratio of a singular component.

Sensor \ Technique	SVD(Red)	SVD(Red) with filtering	SVD(Gray)	SVD(Gray) with filtering
OV2640	7.833	11.16	8.05	10.49
OV5642	8.74	10.84	7.04	10.78
LifeCam	16.82	21.57	20.89	26.75

Table 6.2: Performance of Different CMOS sensors(The values indicate the ratio of the first SVD to the second SVD value)

The same results as in the simulation(only one singular value) could not be replicated because the mask that is produced by the SLM is not completely binary as observed in the previous experiment with SLM. If you observe the images from the sensor closely you can see that the black regions allow some portion of the light to pass through. This results in the image matrix becoming non-binary which in-turn results in secondary SVD components. One way to solve this would be to use a threshold and make the mask image binary but this would result in loss of diffraction and object data. Apart from this factor, another reason why other SVD components are observed is due to the presence of dead-pixel regions in the output data. The values of these pixels over-ride the values of the mask. These effects do not play a major role in lens-based imaging but form a very important role in lens-less imaging. Exposure plays a very important role in the decomposability of the matrix. I first thought of increasing the exposure in order to make the difference between the black and white more prominent (which in-turn increases separability). This idea seems to have worked out. The ratio of singular value to the exposure time is shown in Figure 6.10. The mask becomes separable as the exposure time is increased. However, this comes at a disadvantage. LifeCam has a very limited controllable range of exposure time and the sensor starts quickly saturating at around 2 ms . When the sensor starts saturating, it leads to loss of data which in turn will have an effect on reconstruction. The next step would be to estimate the system matrices M_x and M_y which is described in the next chapter. The best decomposition that I could get was using the LifeCam HD-3000 with exposure adjusted(without saturation) based on figure 6.10. The decomposition of the mask into different components is shown in figure 6.11.

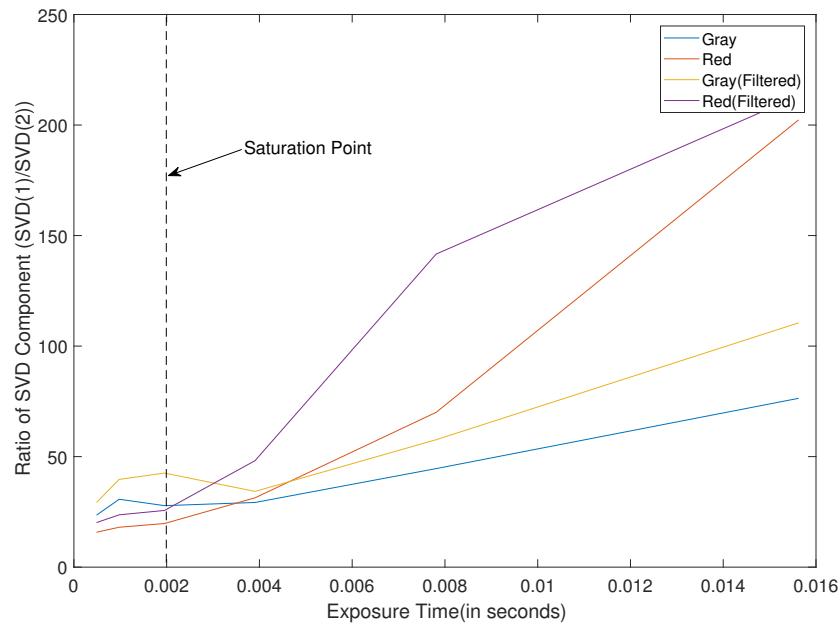


Figure 6.10: Impact of Exposure Time on Singular Values

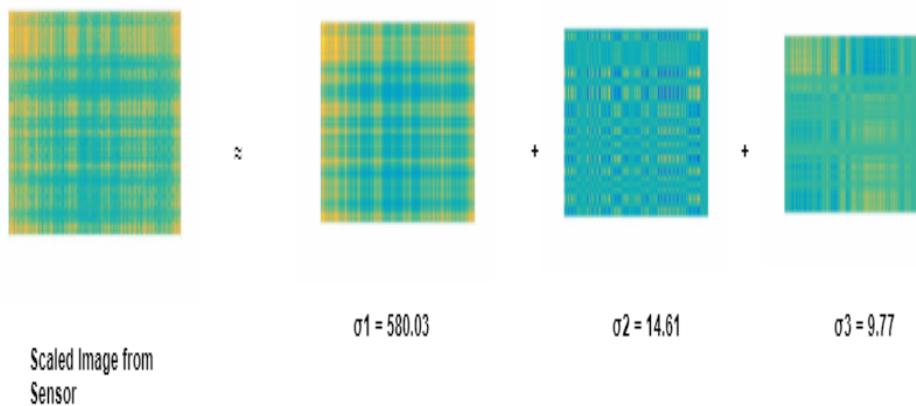


Figure 6.11: Decomposition of best data set(Ratio of first to second component = 39.70)

Chapter 7

Estimation of System Matrices

This chapter will describe the strategy for obtaining the system matrices(M_x and M_y) of the mask produced by the SLM in front of the sensor. M_x and M_y indicate M_A and M_B described in Chapter 3 of the report. If we recollect the knowledge from the previous chapters, M_x and M_y describe the mathematical relation of the object to the sensor.

$$I = M_x O M_y \quad (7.1)$$

The reader may have a question that why do we need to estimate the M_x and M_y when we already know the mask pattern that we project onto the SLM screen. The simulations assume that there is a one-one mapping of the mask-sensor pixels and that they have the same pixel pitch. However, from the manual of the SLM[31] we can see that the SLM has a pixel pitch of $36 \mu m$ and the sensor OV5642 has a pixel pitch of $1.4 \mu m$. The sensor OV2640 cannot be used as of now as we saw in the previous chapter. Due to the differences in the pixel pitch, the effects of compression(which have not been taken into account in the simulations) and ambient noise effects in real-world applications, we need to manually estimate the system matrices by projecting known patterns to obtain perfect reconstructions. One more reason is that the mask pattern has been projected over the entire SLM and we cannot sure about which part of the SLM we are imaging and which points on the SLM contribute to the image on the sensor. We can directly estimate the system matrices instead of manually modeling each component. The experimental setup consists of an LCD screen placed at 20 cm from the SLM-sensor setup. The LCD will be used to project objects and patterns in front of the sensor. The experimental setup is shown in Figure 7.1. Initially, I tried projecting a completely blank white pattern on the LCD but the sensor recorded a blank image. I expected that the sensor would give me an image that would represent the mask itself. I tried to move the mask-sensor closer

to the LCD as I thought that it might be due to not enough light reaching the sensor, but it also made no difference. The reasoning behind this is due to vignetting of light by the pattern. I tried projecting a horizontal dividable pattern on the LCD to see if there is any variation in intensity across the sensor, but there was no difference in intensity across the output image. Then, I decided to project a circular pattern, to see if there is any difference in the readings from the CMOS sensor. I projected two patterns, a white circle in a black background and a black circle in a white. On seeing the outputs through the naked eye, I found that there was not much difference. To my surprise, on subtracting the two output images, there were slight patterns seen on the difference image. So, I decided to develop a strategy that would enable us to estimate the system matrices.

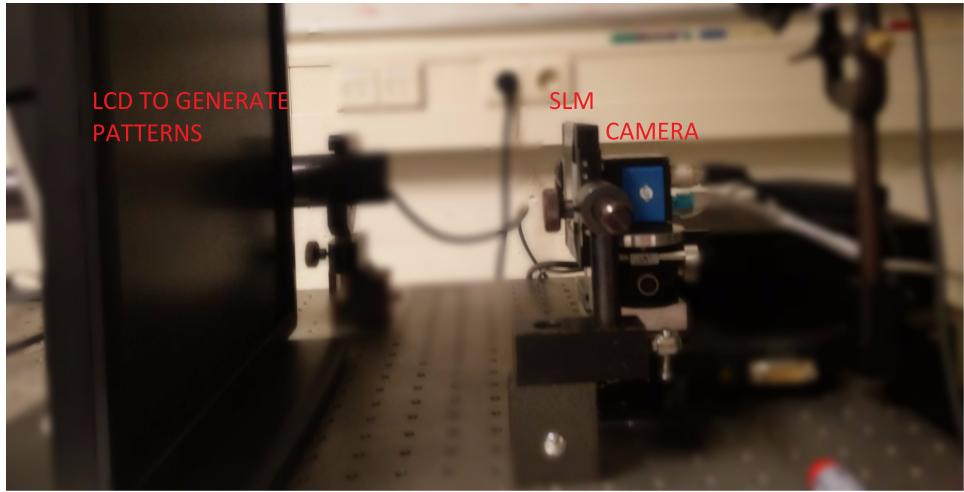


Figure 7.1: Setup for Intial Experiments

7.1 Strategy

The following idea is used to estimate the system matrices.

- We use the same idea from [13] to determine the system matrices. If the scene in front of the mask-sensor arrangement is separable, then the sensor output must also be separable. If the scene is of the form ab^T , then the image formed on the sensor will be of the form:

$$I = (M_x a)(M_y b)^T \quad (7.2)$$

If the scene can be represented in the form of $a1^T$, then the scene formed on the sensor will be,

$$Y = (M_x a)(M_y)^T \quad (7.3)$$

On performing singular value decomposition on the scene and approximating the rank-1 matrix(represented in the form $Y_k = u_k v^T$) from the output image we must be able to estimate the left system matrix using the equation:

$$M_x = u_k a^{-1} \quad (7.4)$$

- For the right system matrix, we can use patterns in the form of $1a^T$ and estimate M_y . In the coming sections, we would look at what kind of pattern can be projected on the screen to accurately estimate the right and left system matrices.

7.1.1 Identity Basis

In order to estimate the system matrices, we can use the idea described previously, but we need to decide what patterns need to be used and how we can mathematically simulate and verify our idea. We use an invertible base matrix to generate different patterns that can be shown on the LCD screen. The basis matrix pattern can any pattern that would be optically feasible and invertible.

$$B = \begin{bmatrix} b_{11} & b_{12} & \dots & b_{1n} \\ \vdots & \vdots & \ddots & \vdots \\ b_{n1} & b_{n2} & \dots & b_{nn} \end{bmatrix}_{n \times n} \quad (7.5)$$

For estimating the left system matrix we need to extract the columns from the basis matrix that we use and multiply it with a row vector of 1s as shown by equation 7.8.

$$1_{row} = [1 \ 1 \ \dots \ 1]_{1 \times n} \quad (7.6)$$

$$b_i = \begin{bmatrix} b_{i1} \\ b_{i2} \\ \vdots \\ b_{in} \end{bmatrix}_{n \times 1} \quad (7.7)$$

$$pattern_i = \begin{bmatrix} b_{i1} \\ b_{i2} \\ \vdots \\ b_{in} \end{bmatrix}_{n \times 1} \times [1 \ 1 \ \dots \ 1]_{1 \times n} \quad (7.8)$$

The image produced by $pattern_i$ on the sensor can be decomposed into $u_i v^T$ using the rank-1 estimation obtained from singular value decomposition(SVD). We need to accumulate the sensor output from each b_i multiplied by the row-one vector and find the corresponding u_i . These u_i need to be put together to form an $n \times n$ matrix. The accumulated u_i values correspond

to the left system matrix combined with the basis matrix B . We can then invert it to obtain the actual system matrix as shown in equation 7.9.

$$M_x = [u_1 \ \dots \ u_i \ \dots \ u_n]_{n \times n} B^{-1} \quad (7.9)$$

Similarly, two obtain the right system matrix using patterns obtained from multiplying the rows from the basis matrix and columns of 1s as illustrated by equation 7.10. The accumulated v_i obtained from singular value decomposition can be inverted using the inverse of the basis matrix as done for the left system matrix. The procedure for obtaining the system matrices is illustrated in Figure 7.2.

$$pattern_j = [b_{j1} \ b_{j2} \ \dots \ b_{jn}]_{1 \times n} \times \begin{bmatrix} 1 \\ 1 \\ \vdots \\ 1 \end{bmatrix}_{n \times 1} \quad (7.10)$$

The simplest basis matrix that could be inverted is the identity matrix. The patterns produced by the identity matrix will be a shifting row of ones(white) in a black background for the left system matrix and a shifting column of one in a black background for the right system matrix. This is shown in Figure 7.3.

This entire procedure was simulated in MATLAB like in the previous section and reconstructions obtained using system matrices obtained from the procedure is compared. The reconstructions obtained by simulating the LCD patterns and obtaining the system matrix is shown in Figure 7.4. It can be seen from the figure that the reconstruction obtained using the procedure mentioned leads to a poorer reconstruction than the one which we obtained using the known diffracted mask pattern. The system matrix obtained by using the procedure explained above does not provide accurate reconstructions. This problem was traced to the Singular Value Decomposition(SVD) procedure which is used for computing the left and the right vectors when analyzing the scene separability. Using any other basis matrix other than the identity matrix for this procedure fails as SVD is non-linear and not all matrices can follow a pattern like the identity matrix in which there would be no linear relationship between the rows. One more issue with using the identity matrix is that this identity basis matrix generates a very less amount of light. Projecting these patterns on the LCD did not provide any noticeable change in the sensor readings in the experimental setup. So, it was decided to use some other basis matrix for estimating the system matrices. The inaccuracy in estimating the left and right vectors is resolved mathematically as explained in the next section.

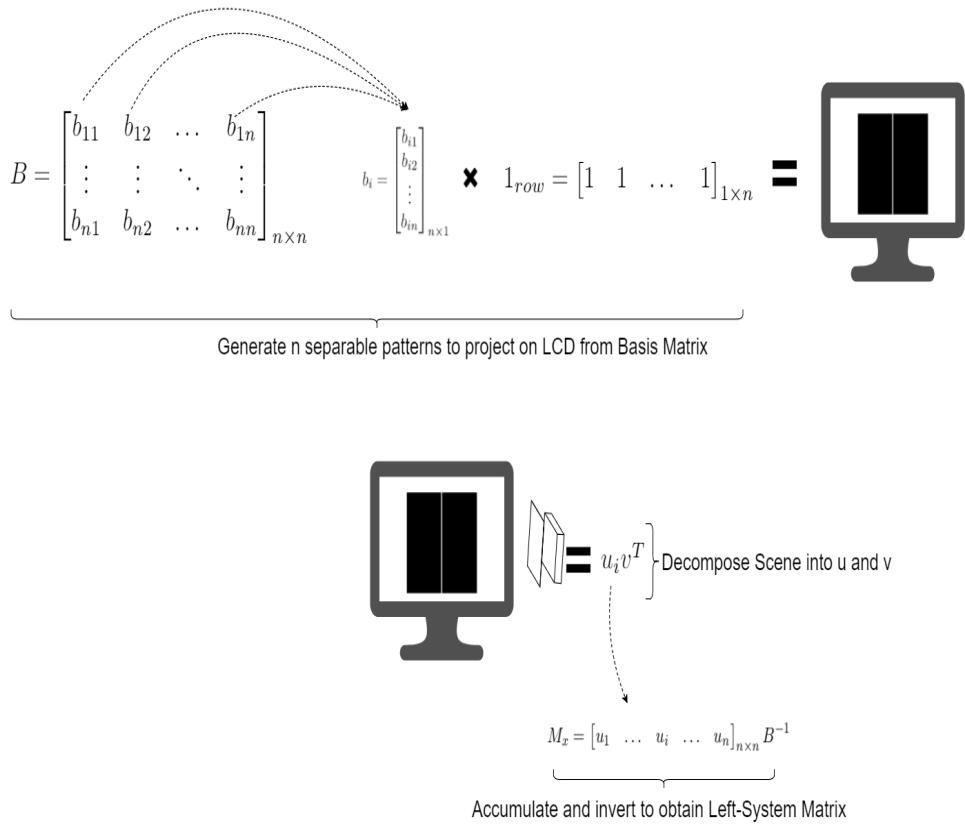


Figure 7.2: Procedure for obtaining the left system matrix

7.1.2 Hadamard Basis

In this section, we will first discuss an alternative way of obtaining the left and the right system vectors instead of using singular value decomposition as it does not provide an accurate estimation of a separable scene in this case. Consider that a scene of the form $a1^T$ is imaged by the sensor with the mask. The image on the sensor can be written in the form given by equation 7.3. It can be re-written as shown in equation 7.11.

$$Y(x, y) = \phi_1(x)\phi_2(y) \quad (7.11)$$

The term $\phi_1(x)$ and $\phi_2(y)$ represent $(M_x a)$ and (M_y) of equation 7.3 respectively. The integral of equation 7.11 can be represented by equation 7.12. When we project a scene of the form $a1^T$, equation 7.12 can be re-written as equation 7.13 as a constant 1 vector is the right vector that is

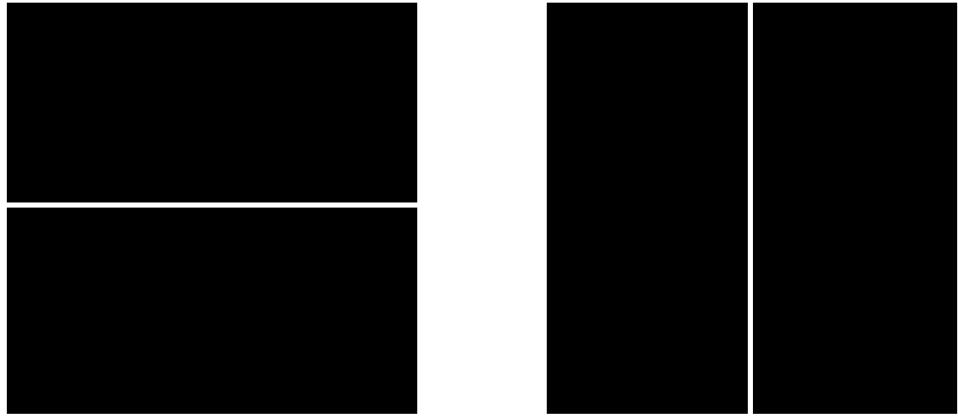


Figure 7.3: Pattern on LCD that would be generated with left and right system matrix



Figure 7.4: This figure shows the differences in reconstruction. The figure on the leftmost corner is the original object, the middle image represents the inversion obtained using the known diffracted mask pattern, and the right image indicates the reconstruction obtained using simulated LCD patterns and obtaining system matrix. It can be seen that there is an extreme loss of detail when we try to manually obtain the system matrix using the procedure stated.

used to generate the pattern.

$$\int Y(x, y) \propto \phi_1(x) \int \phi_2(y) dy \quad (7.12)$$

$$\int Y(x, y) \propto \phi_1(x) k \quad (7.13)$$

When we sum over the sensor output image in the y-direction while projecting patterns of the form $a1^T$, we will be only left with the left system vector(u_i) multiplied by a constant. Similarly, when we sum over the sensor output image in the x-direction while projecting patterns of the form $1a^T$, we will be only left with the right system vector(v_i) multiplied by a constant. This also reduces the computational load instead of using MATLAB function `svd` which is highly computationally intensive. The same procedure mentioned in the previous section can be used with only modifications

to the estimation of left and right system vectors. The vectors need to be put together to obtain the system matrices multiplied by the basis matrix. The accumulated matrix can then be inverted using the inverse of the basis matrix. Since, we solved the problem of estimating the left and right system matrices by using a simple summation, let us now focus on using a better basis matrix for estimating the system matrices.

The identity matrix provides a very less amount of light since it produces only one row of emitting light. So, I decided to test some striped separable patterns and see if we are able to receive any response from the sensor. It was observed that striped patterns are able to produce some significant sensor response on estimating the left and right system matrix using SVD. So, I decided to look for matrices that can produce striped patterns on the screen.

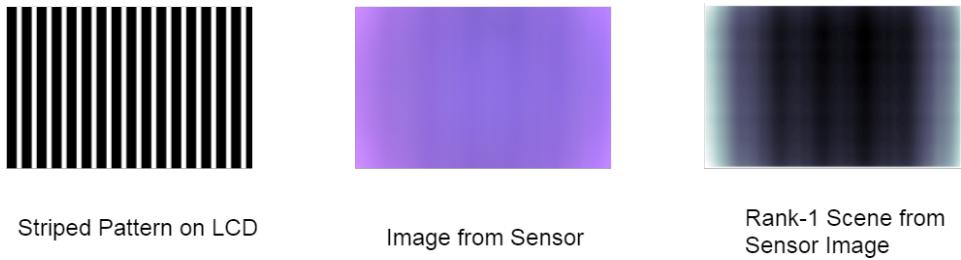


Figure 7.5: This figure indicates the response of the sensor. The right most image is put on the LCD screen. The middle portion indicates the output image from the sensor. The third indicates the rank-1 estimate of the scene obtained using SVD

In order to accurately estimate the system matrices, we need to project multiple striped patterns. We want a matrix that can produce multiple striped patterns which can be accumulated and inverted to obtain the system matrices. One such pattern is a Hadamard pattern which is widely used in compressed image sensing[10][13]. This basis matrix is also used in previous studies is the Hadamard matrix H whose inverse is of the form given by equation 7.14. The size of the Hadamard matrix n is always in the powers of 2.

$$H^{-1} = \frac{1}{n} H^T \quad (7.14)$$

However, one disadvantage of Hadamard matrix is that it has negative one values(instead of 0s) which cannot be optically programmed. However, we can follow some mathematical tricks to make it optically feasible. Consider a 2×2 Hadamard matrix shown in equation 7.15. Let us take the keep the matrix and also take the negative of the matrix.

$$H_2 = \begin{bmatrix} 1 & 1 \\ 1 & -1 \end{bmatrix} \quad (7.15)$$

$$H_2^+ = \begin{bmatrix} 1 & 1 \\ 1 & -1 \end{bmatrix} \quad H_2^- = \begin{bmatrix} -1 & -1 \\ -1 & 1 \end{bmatrix} \quad (7.16)$$

In order to make the mask optically feasible, let us set the negative entries of equation 7.16 to zero.

$$H_2^+ = \begin{bmatrix} 1 & 1 \\ 1 & 0 \end{bmatrix} \quad H_2^- = \begin{bmatrix} 0 & 0 \\ 0 & 1 \end{bmatrix} \quad (7.17)$$

We can see from equation 7.17 that

$$H_2 = H_2^+ - H_2^- \quad (7.18)$$

By projecting binary patterns of the form given by equation 7.17, we can make an optically realizable Hadamard pattern. However, a disadvantage is that we need to project two kinds of patterns (one for H^+ and one for H^-) and subtract the sensor images to get the reading for the original Hadamard pattern. An example of vertical and horizontal Hadamard patterns is shown in Figure 7.6.

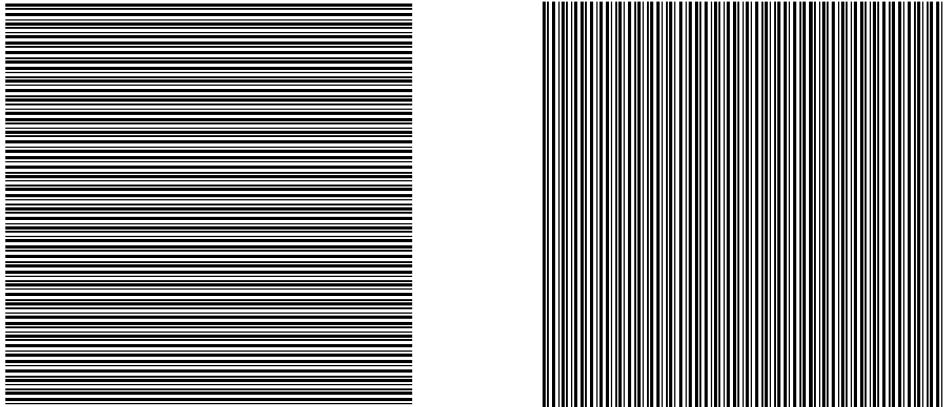


Figure 7.6: An example of vertical and horizontal Hadamard pattern(H^+) that can be used for system matrix estimation. Note that the same procedure as mentioned previously holds. Only an additional pattern needs to be incorporated to make the Hadamard pattern optically feasible

An example of reconstruction using the Hadamard patterns is shown in Figure 7.7. It can be seen from Figure 7.7 that estimating the system matrix manually provides a lot better results and preserves a lot more detail than using the known diffracted mask pattern.

We can see that both the basis matrices need measurements from $2N$ calibration patterns to reconstruct $N \times N$ resolution images. We can generate $2N$ Hadamard patterns and estimate the accurate system matrix that can provide extremely good reconstruction results as seen in the simulation.

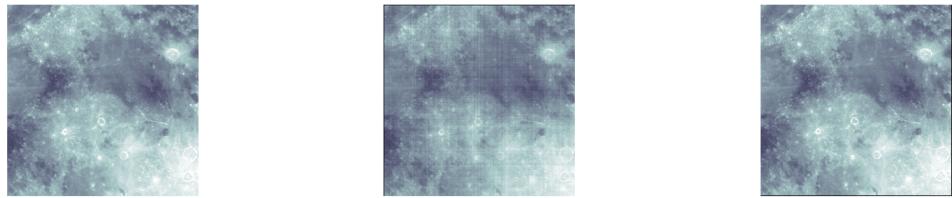


Figure 7.7: This figure indicates the reconstructions obtained using the Hadamard matrix as the basis matrix and after summing to obtain the separable scene components. The leftmost image indicates the original object, the middle indicates the reconstruction obtained with known system matrix and the right indicates the reconstruction with the system matrices obtained by projecting Hadamard patterns. It can be seen that the effects of noise are no longer visible and the reconstruction is perfect.

This scheme of estimating the system matrices is also extremely resistant to noise which was simulated by adding random noise equivalent to the signal on the LCD screen. However, it is extremely sensitive to rotation angles. The LCD must be exactly parallel to the sensor in order for this scheme to work. In the actual, this can be achieved by manually aligning the screen while computing the SVD components. The perfect alignment would give us the highest value of the singular component ratio. The process must be repeated as mentioned in the previous chapter where the sensor was aligned with the SLM using singular value decomposition ratios. The simulations prove that the strategy mentioned above can be used to estimate the system matrices even in the presence of noise from the LCD.

Chapter 8

Conclusions and Future Work

8.1 Goals and Research Questions revisited

In the beginning of the chapter, a research question and goals for the project were proposed. Now, let us revisit them to find out whether we have reached the goals of the project. The project was divided into these four sub-questions as given below:

- What would be the image sensor that can be used for the camera?
In chapter 2 of this report, a survey of image sensors is conducted and the drawbacks of each sensor are presented. Based on various factors, OV2640 and OV5642 were chosen. This also indicates the achievement of the first goal.
- How do we design the hardware and software for such a camera that can be used in Delfi-PQ satellite?
The main factor in choosing OV2640 and OV5642 was the presence of open source libraries, and open source electronic interface hardware. The software and the hardware mechanism for controlling the cameras have been described in Chapter 4 of the report. All the experiments described in the later chapters of the report were developed using the same hardware and software described in Chapter 4. This also indicates the achievement of the second goal.
- What would be the field of view and spatial resolution of the lensless camera?
An experimental setup to determine the acceptance cone of the image sensor has been devised. The experimental results were incorporated into the previously completed simulations. Based on the experimental results, OV2640 had an acceptance angle of 43.6 degrees. It was found

that the field of view of the lensless system had reduced 38 percent and 31.8 percent in the horizontal and vertical directions compared to a conventional lens based system. The effective area of the sensor that could be used also reduced by 52 percent. The spatial resolution of the designed camera was calculated and the entire procedure for calculating the spatial resolution is described in Chapter 2 and Chapter 5 of the report. This also indicates the achievement of the third goal. The experiments for finding out the acceptance angle was performed using the OV2640. The OV5642 has an acceptance angle of 23 degrees(given by the datasheet). However, this claim is yet to be verified experimentally.

- What would be the computational algorithm that would be used in such a lensless camera?

The computational algorithm mainly depends on the mask that we use for imaging. Doubly Toeplitz masks were chosen since they retain the separable property even in the presence of diffraction. The computational reconstruction method for separable doubly Toeplitz mask has been studied and simulated. It was found in the simulations that separable doubly Toeplitz mask could be used to reconstruct objects even in the presence of diffraction effects. The entire simulation workflow is described in Chapter 3 of the report.

- How do we experimentally prove the concept of lensless imaging?

Experimental verification of lensless imaging required multiple stages of experiments. After determining the field of view of the OV2640 sensor, the imaging of the separable mask was tried using OV2640. However, it was found out that OV2640 could not be used due to the limitation of the onboard FIFO buffer of the camera. Because of this, we decided to use OV5642 which has a bigger FIFO buffer. OV5642 is able to image the mask perfectly and preserves the separable property of the mask. The entire experimental approach was done using singular value decomposition and is mentioned in Chapter 6 of the report.

The next step was to determine the system matrices of the lensless camera. To do this, we decide to use a Hadamard basis matrix as it could provide enough amount of light to produce a measurable sensor response. Using a basis matrix also provided better reconstruction and preserved the original object property as seen in the simulation results. This method requires us to use $2N$ calibration patterns on the LCD if we want to reconstruct images of resolution $N \times N$. This method was not verified experimentally and forms the final step of proving the concept of lensless imaging experimentally. The strategy and scheme for achieving this are described in Chapter 7 of the report. This indicates that there is some more experimental verification required to

achieve the final goal.

Now, let us come to the main research question: **Is it possible to design “lensless coded aperture” cameras with a small form-factor(thickness ≤ 10 mm) using COTS(commercially available off-the-shelf) components that can be used in U-class Spacecraft ?**

The experimental results with commercially available camera modules OV2640 and OV5642 provide a good insight into the lensless imaging methodologies. The previous studies done in this field did not have any memory limitations like we faced with OV2640. The camera with bigger memory such as OV5642 could retain the properties of the mask when we experimentally tested them. A separable scene on the outside also yields a separable scene on the image sensor. A scheme for determining the system matrices of a lensless imaging system is designed and simulated. However, the experimental determination of this scheme has not yet been verified. The simulations and experiments done in this work provide a good picture and insight into the concept of lensless imaging as a whole. The experimental results achieved till now indicate that commercially available cameras can be used but more experiments need to be performed before this question can be answered with more certainty.

8.2 Future Work

With the developed calibration patterns, it would be possible to reconstruct images of resolution $N \times N$. N should be a power of 2 since the Hadamard basis matrices can only be generated as a square matrix whose rows and columns have sizes which are a power of 2. With the OV2640(currently not usable due to memory limitations) and OV5642, a maximum possible image of resolution 1024×1024 , can be reconstructed if we are able to estimate the system matrices using these sensors experimentally. OV2640 consumes approximately 465 mW for a full-resolution picture(1600×1200) and OV5642 consumes 1.165 W for a full-resolution picture(2592×1944). The Delfi-PQ team has allotted a 4W budget for the entire imager(including the microcontroller). If OV5642 is chosen, 2.8W will remain for the microcontroller and the RS-485 data interface circuitry which would be used for communication with the main onboard computer of the satellite. At this stage, it would not be possible to decide the exact thickness of the camera as the final-proof-of-concept is not yet available.

It was observed during the experiments that the sensor was not able to produce an output in correlation with the simulation data. The problem was traced to the non-binary behavior of the mask produced by SLM. A fabricated photomask can provide us with superior performance compared to an SLM. It would be possible to stick the photomask to the glass plate on the sensor(which leads to a thickness of $500 \mu\text{m}$). With the current setup,

it was not possible to bring the sensor closer than 1 centimeter. There is a great scope for developing the work mentioned in this thesis. This work can be improved and extended in the following ways:

- Experimental determination of System Matrices: A scheme for experimental determination of the system matrix has been described in Chapter 7 of the report. This needs to be completed to completely realize the concept of lensless imaging. The scheme described is extremely time-consuming as it requires $2N$ measurements(one-time procedure) to perform complete reconstructions for $N \times N$ resolution images. This scheme can also be improved to reduce the number of measurements needed to accurately estimate the system matrices.
- Fabrication with masks: This work uses transmissive Spatial light modulators(SLM) to simulate the effects of a mask. It was observed that a complete binary mask cannot be achieved with this equipment. Lithographic photomasks can be fabricated and can offer better performance than using an SLM. The system matrices must also be estimated for a photomask based lensless imaging system.
- Improving the computational method for reconstruction: This work uses regularization along with matrix inversion to perform reconstructions. This method can also be improved using other methods to denoise the reconstruction such as SVD, BM3D and total variation based methods[13]. These methods could be tried out on the existing simulations and studied whether they provide better reconstructions.
- Hardware Improvements: OV2640 could not be used due to the limited onboard memory. The future work can also look into improving the camera hardware by replacing the memory of the camera module. This would also require a change in the hardware/software implementations of the library. Arducam can be contacted on how to achieve this. Also, they release improved versions of the camera modules every year.

Appendix

Fresnel Propagation Model

In this section, we will briefly discuss the Fresnel propagation model used for obtaining the effects of diffraction. The model is based on [41] and the MATLAB model developed at Optica Group was used. The fresnel number for the system is given by the equation

$$N_F = w^2/(\lambda z) \quad (8.1)$$

where w is the half-width of the square aperture, λ is the wavelength, and z is the distance between the source plane and the object plane. In the simulations, λ was taken to be 550 nm, since the average wavelength of the visible light spectrum is 550 nm. The distance z is taken to be 5 mm. w is basically the pixel size(assumed to be $2.2\mu m \times 2.2\mu m$) of the mask plane multiplied by the total number of openings in the aperture. The simulation assumes that the sensor reacts to only one specific wavelength and that signals from other wavelength sources are ignored. The fresnel number depends on the source plane(i.e the mask). For a single pinhole system, the fresnel number is 0.044 and for a doubly-toeplitz mask of size 1024×1024 , it would be 20.34. It can be safely be assumed that the system lies in the fresnel region for this specific condition for this specific fresnel number range[41] as the system still does not reach far-field region. When modeling the diffraction effect, we have a source plane and an observation plane. In our case, the source plane is the mask and the observation plane would be the sensor. This is shown in Figure 8.1. In this case, the diffraction effects can be given by the equation 8.2.

$$U_2(x, y) = \frac{e^{jkz}}{j\lambda z} \int \int U_1(\xi, \eta) \exp\left(\frac{jk}{2z}[(x - \xi)^2 + (y - \eta)^2]\right) d\xi d\eta \quad (8.2)$$

This expression can also be written in the form of equation 8.3.

$$U_2(x, y) = F^{-1}(F(U_1(x, y))F(h(x, y))) \quad (8.3)$$

where

$$h(x, y) = \frac{e^{jkz}}{j\lambda z} \exp\left(\frac{jk}{2z}(x^2 + y^2)\right) \quad (8.4)$$

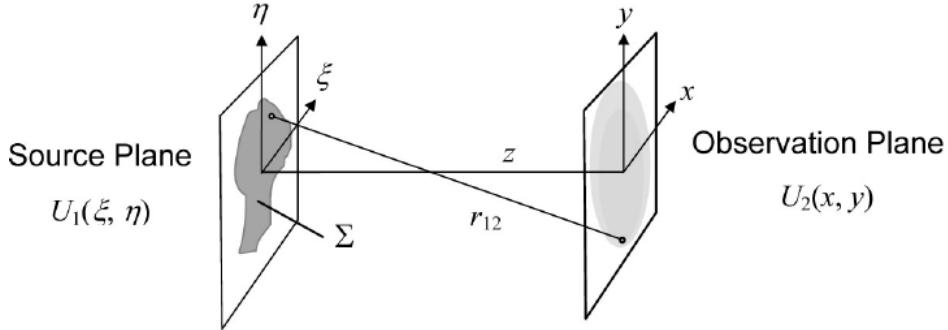


Figure 8.1: Source Plane and Observation Plane

The mask transfer function for the binary mask is calculated using equation 8.3. This obtained pattern on the observation plane is then used in the place of the binary mask to simulate the effect of a diffracted mask.

Camera Dimensions

This section shows the dimension of the camera module as provided by the camera vendor. The measurements for the front side of the camera module is shown in Figure 8.2. The OV2640 and OV5642 cameras upon the lenses removed have a thickness of 4.29 mm and 2.70 mm respectively. The difference in thickness is due to the presence of AL422B FIFO Buffer chip which increases the thickness of the camera. The thickness is the sum of the length of the circuit board plus the memory buffer element(which protrudes the most out of the circuit board). The camera modules are shown in Figure 8.3.

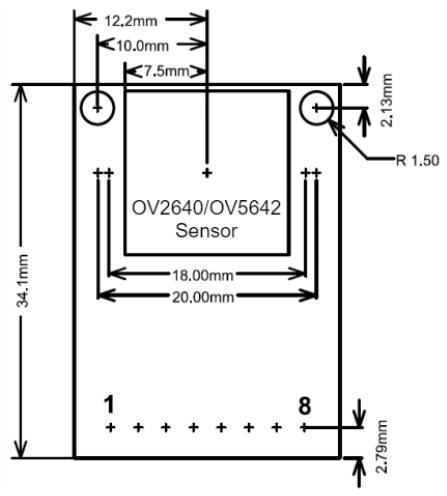


Figure 8.2: Dimensions of both OV5642 and OV2640 camera modules



(a) OV2640 Camera Module



(b) OV5642 Camera Module

Figure 8.3: Camera Modules with lens removed

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